

OOF And Beyond: 2D Plasticity and 3D Microstructure-based Modeling

A. Ayyar¹ and N. Chawla²

¹Department of Mechanical and Aerospace Engineering

²School of Materials

Fulton School of Engineering

Arizona State University

Tempe, AZ 85287-6006 USA

OOF Workshop - June, 2001

11:00 Myriad Uses

Craig Carter, M.I.T.

11:30 Discussion

11:45 3-D Meshing

Panos Charalambides, Univ. of Maryland Baltimore County

12:15 Discussion

12:30 - 13:45 Lunch - NIST cafeteria

Thursday Afternoon - PROJECT SESSION

A session for OOF users and potential users, discussing what they have done and/or what they would like to do.

13:45 OOF Research at Ford Research Lab

Alex Bogicevic, Ford Research Lab

14:00 Thermal Conductivity Simulations for TBC's

Jim Ruud, GE CRD

14:20 Microstructure-Properties Correlation for Thermal Spray TBC's

Matthias Oechsner, Siemens Westinghouse Power Corporation

14:30 Overview of OOF Research at ORNL

Chun-Hway Hsueh, Oak Ridge Nat'l Lab

14:40 Discussion

15:00 OOF Research in Polymers

Martin Chiang, Polymers, NIST

15:15 Piezoelectricity and Beyond

Edwin Garcia, M.I.T.

15:35 OIM-2-OOF code

Venkata Vedula, Sandia National Labs

15:45 Discussion

15:55 **Break**

16:10 Residual Stresses in Ceramics

Yi Fang, Univ. of Houston

16:25 Microcracking in Alumina/Aluminum Titanate

Susan Galal Yousef, TU-Darmstadt

16:35 Thermomechanical stresses in composites

Nik Chawla, Arizona State Univ.

16:50 Marcelling Effects on Layered Composite Deformation

Venkata Vedula, UTRC

16:55 Discussion

17:10 Zebulon: Object-Oriented, Finite Element Software for Material

Behavior Development, Alan C. Mueller, Northwest Numerics, Inc.

17:20 Elle: Microstructure Modelling of Geological Materials

Lynn Evans, Monash University

17:25 Thermal Degradation of Marble

Thomas Weiss, Georg August Universität

17:45 Discussion

18:00 to Dinner

Modeling efforts at ASU

2D Modeling
Elastic
OOF

OOF in Education

2D Modeling
Elastic-plastic
ABAQUS

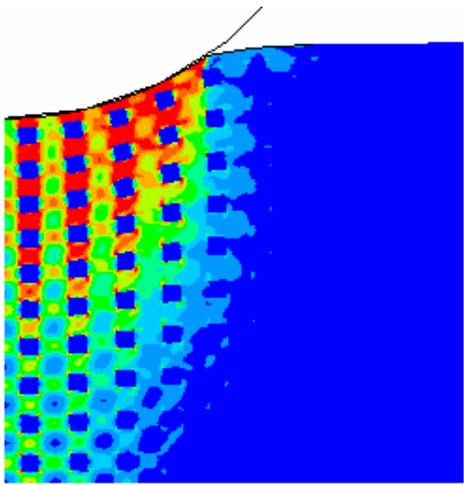
2D Crack growth modeling
Elastic
FRANC2D/L

3D Visualization
Serial Sectioning
ImageJ, RasterVect, SurfDriver, Mimics

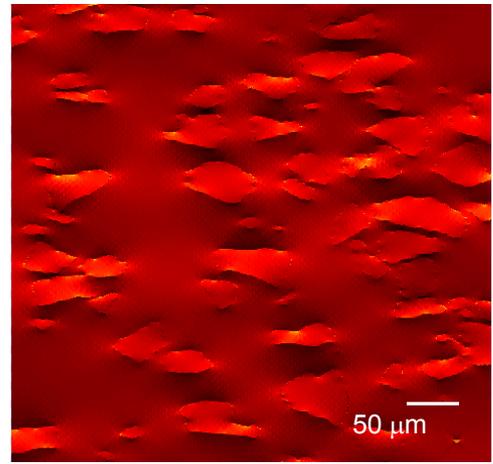
3D Modeling
Elastic-plastic
ABAQUS

3D Crack growth modeling
Elastic
FRANC3D

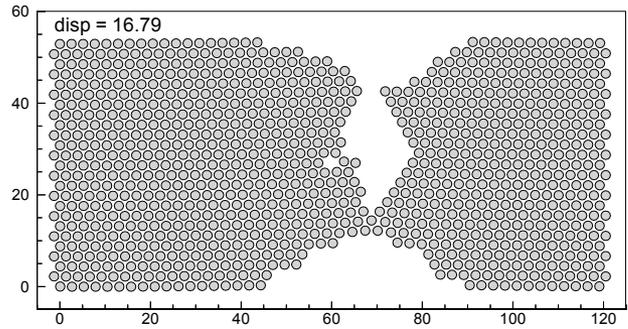
Modeling at multi-length scales



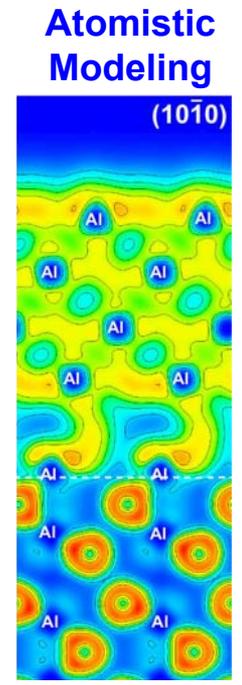
**Continuum-based
Modeling**



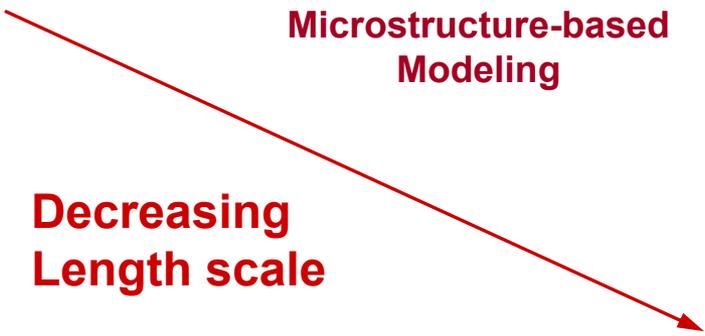
**Microstructure-based
Modeling**



**Dislocation-based
Modeling**

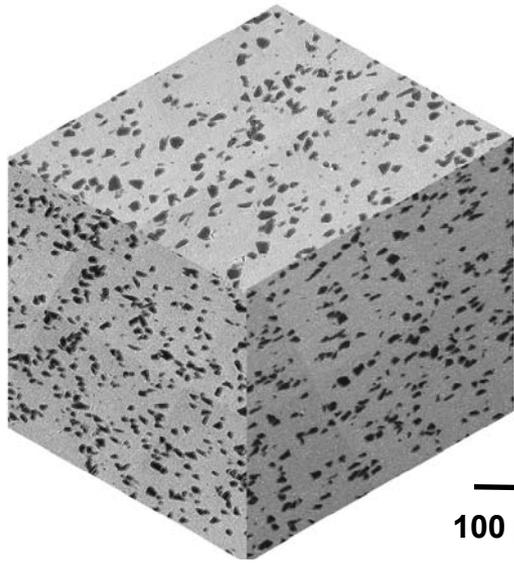


**Atomistic
Modeling**



**Decreasing
Length scale**

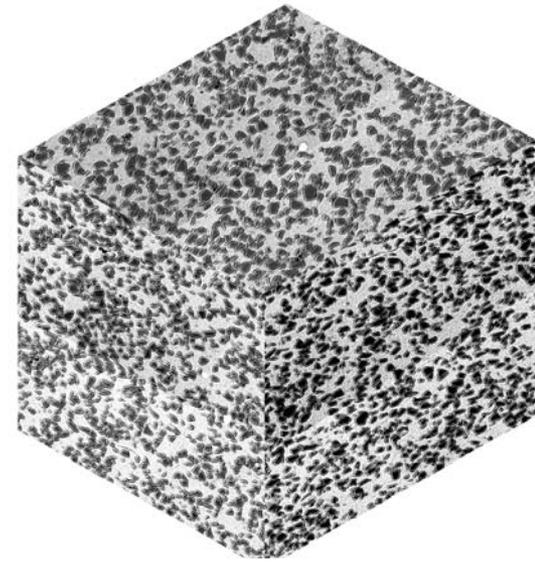
Microstructure of extruded particle reinforced aluminum



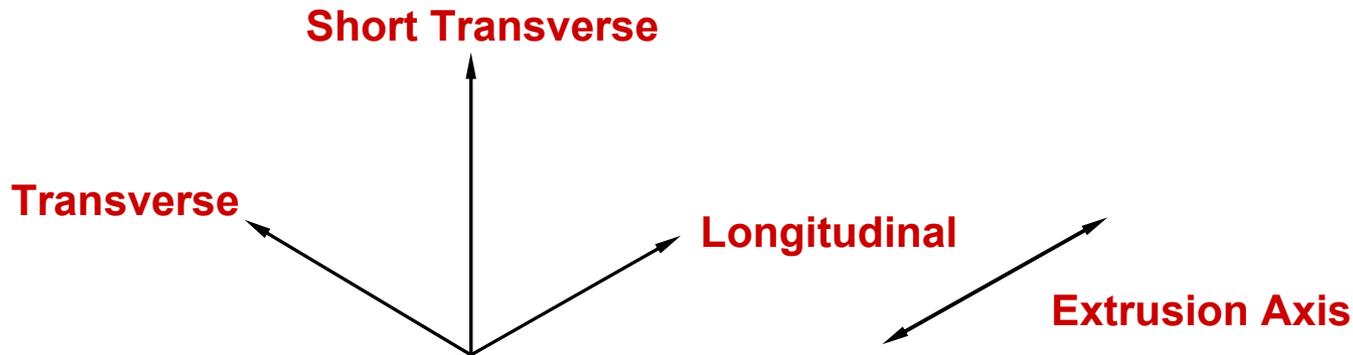
2080/SiC/10_p
F(600)



2080/SiC/20_p
F(600)



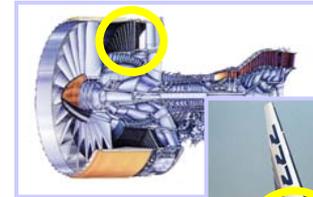
2080/SiC/30_p
F(600)



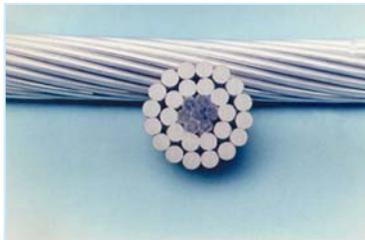
Applications of MMCs



Cylinder Liners



MMC replaced gr/epoxy FEGV in PW 4XXX engines

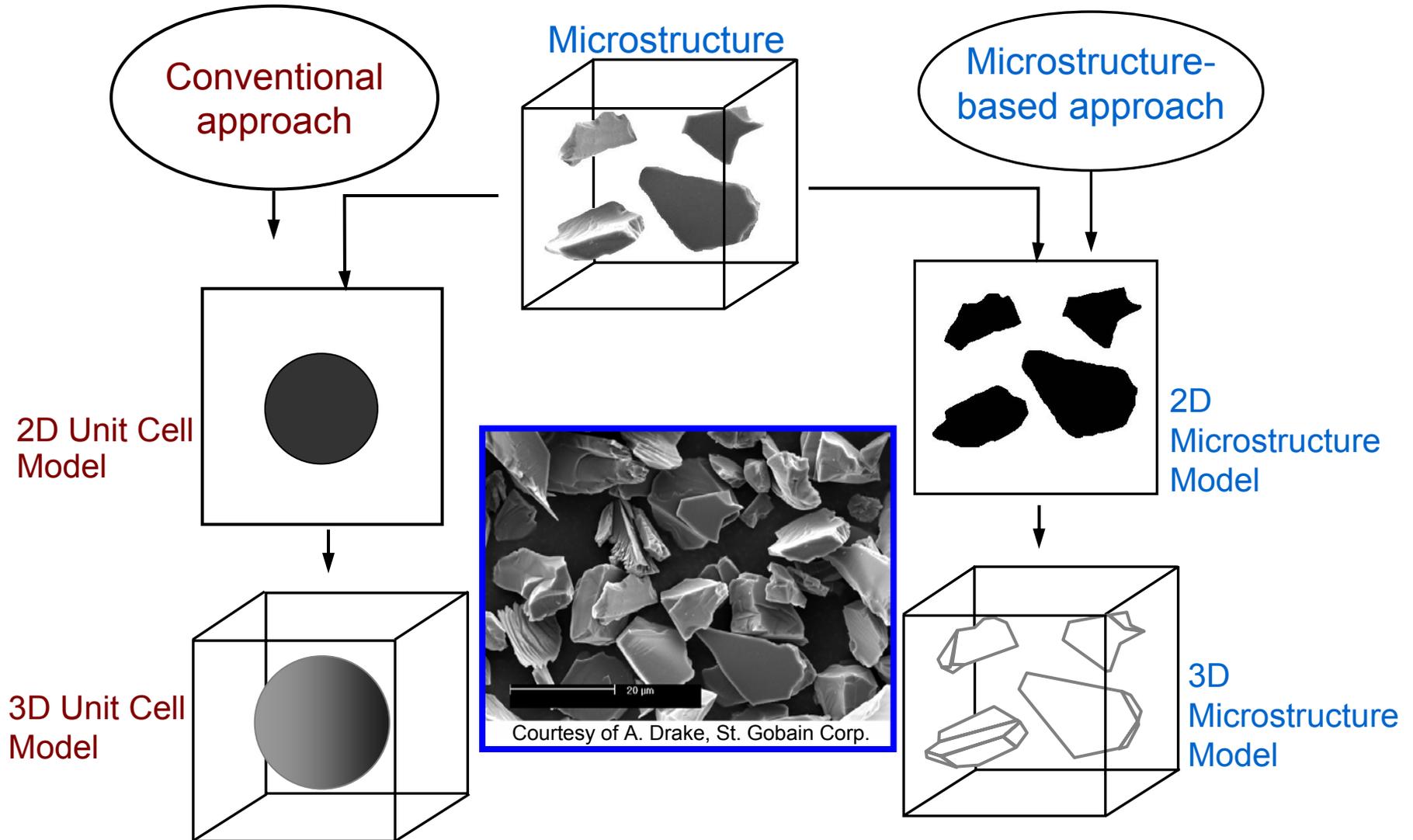


Power conductors

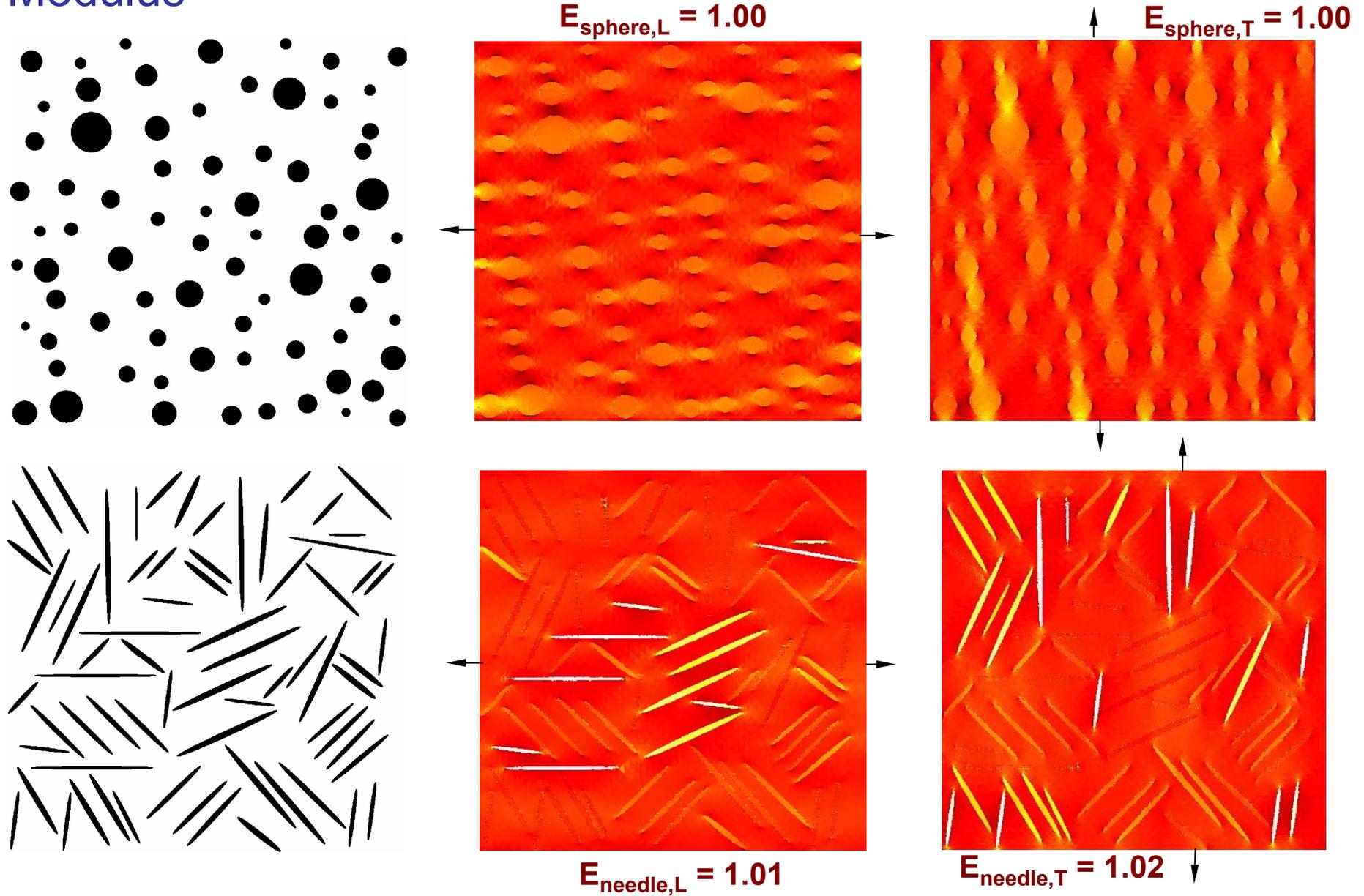
MMC Spikes for Track and Field Cleats



Approaches to numerical modeling of composites

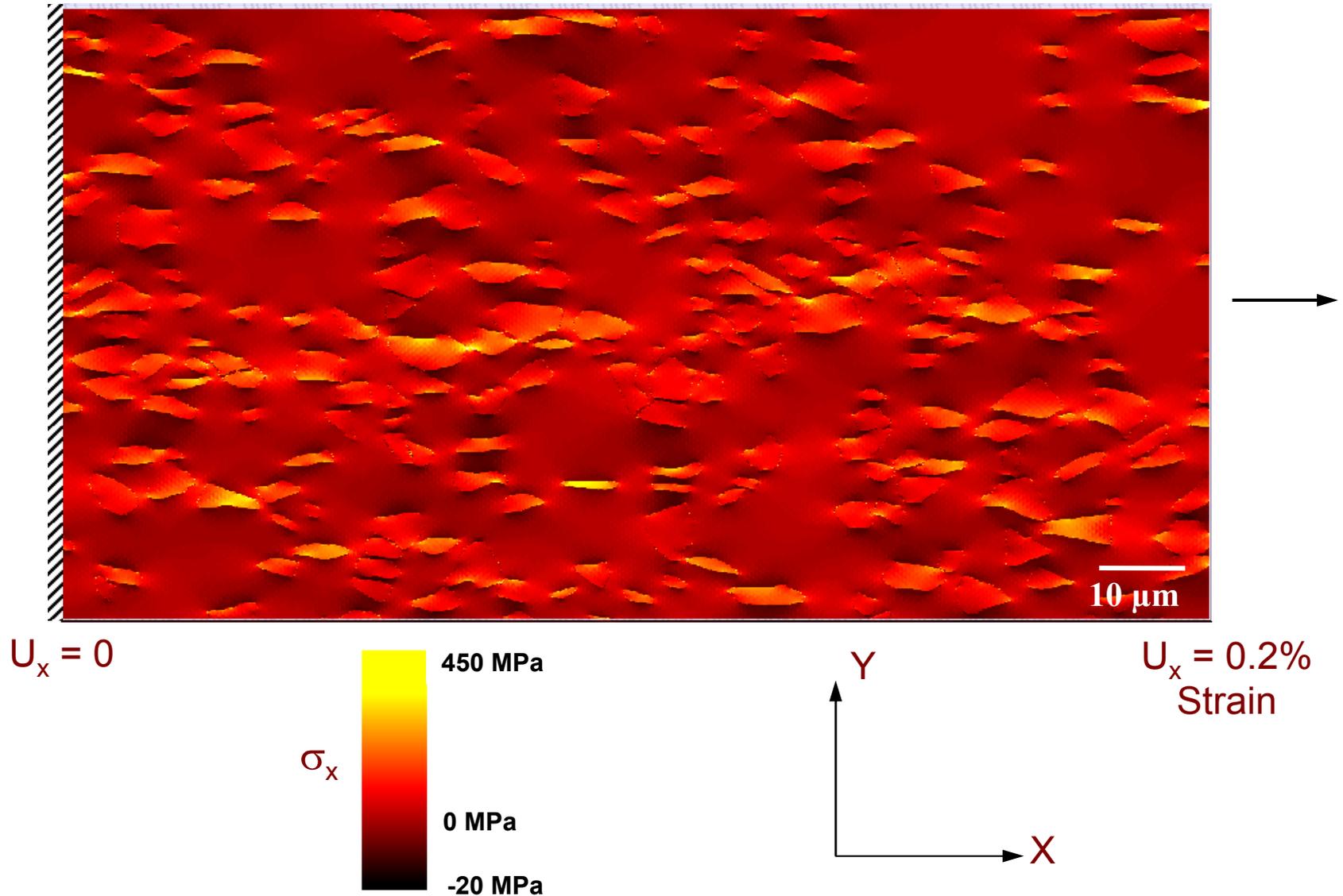


Modeling the effect of second phase morphology on Young's Modulus



2D Microstructure-based finite element analysis

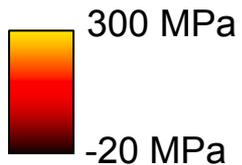
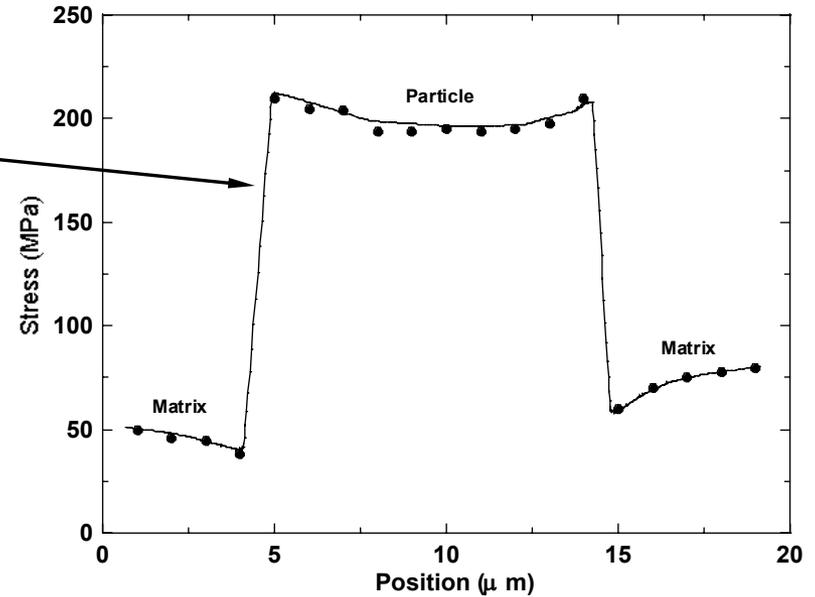
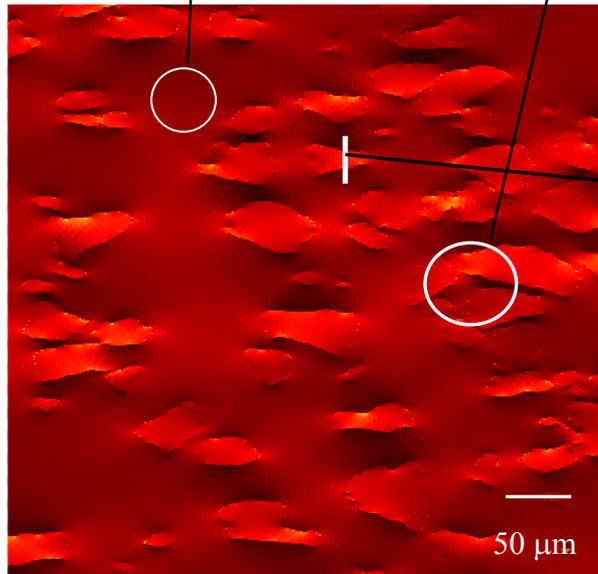
Elastic analysis



Stresses are inherently based on local microstructure characteristics – Elastic analysis

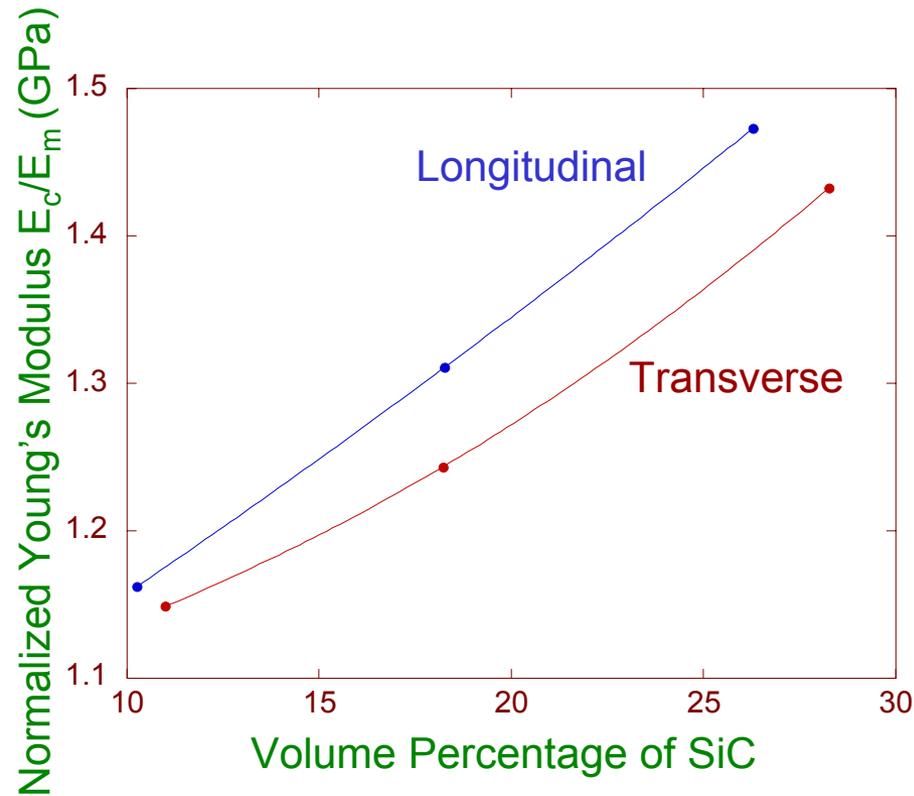
Particle free region, 82 MPa

Clustered region, 120 MPa



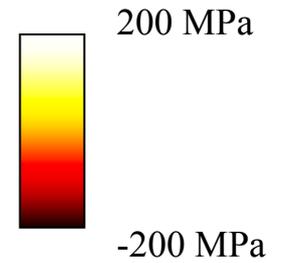
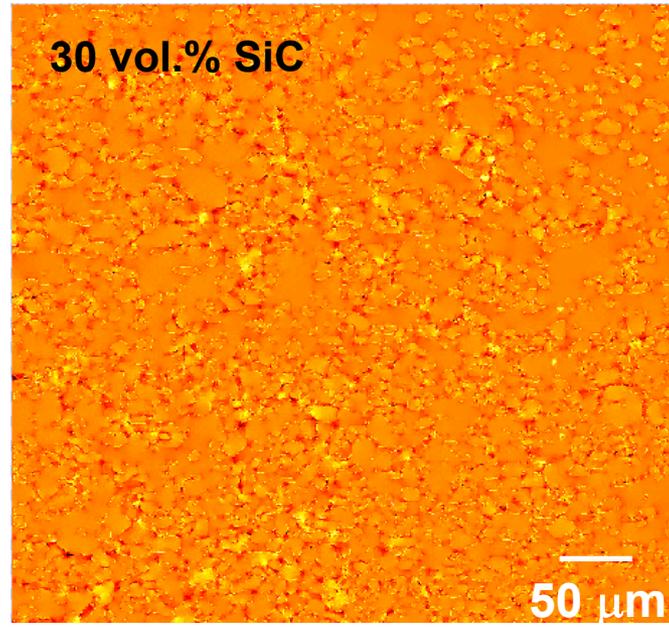
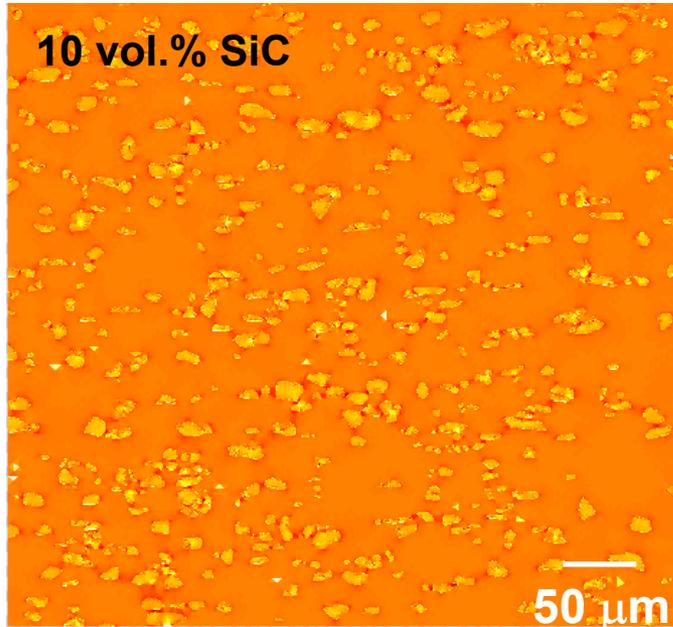
σ_{xx} (0.1% applied strain)

2D Microstructure-based modeling Results of tensile anisotropy

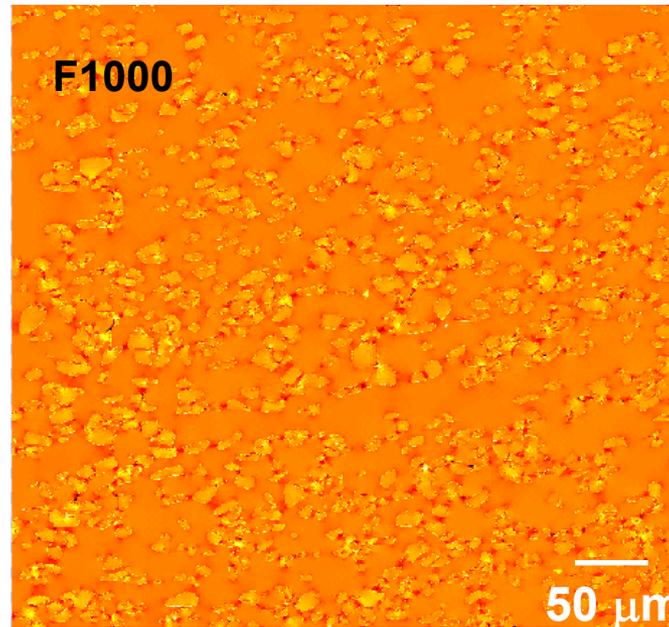
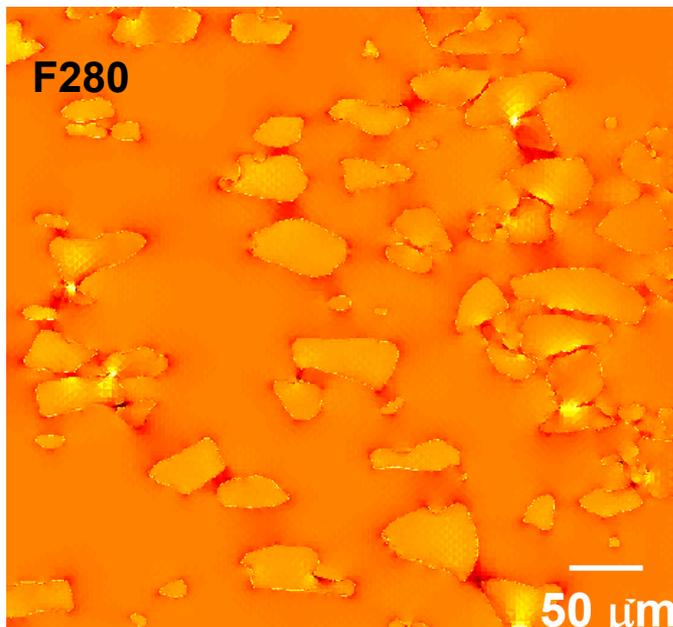


Microstructure based FEA was able to predict anisotropy in normalized Young's modulus

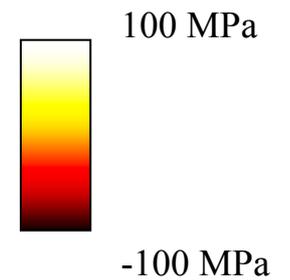
Thermal stress distribution



with increasing SiC
volume fraction

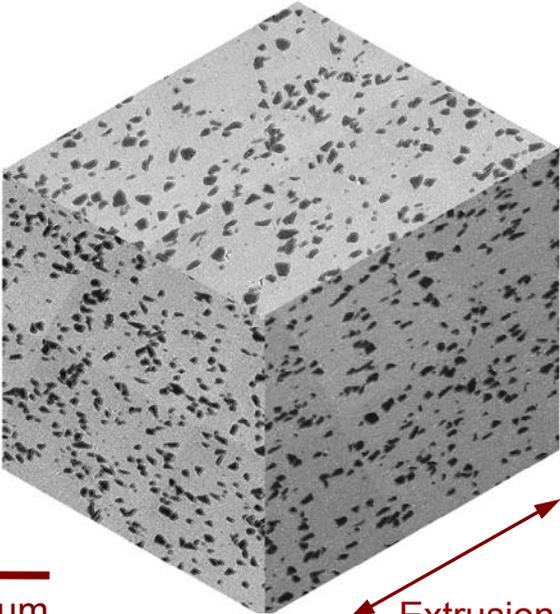


with decreasing SiC
particle size



Particle reinforced metal matrix composites

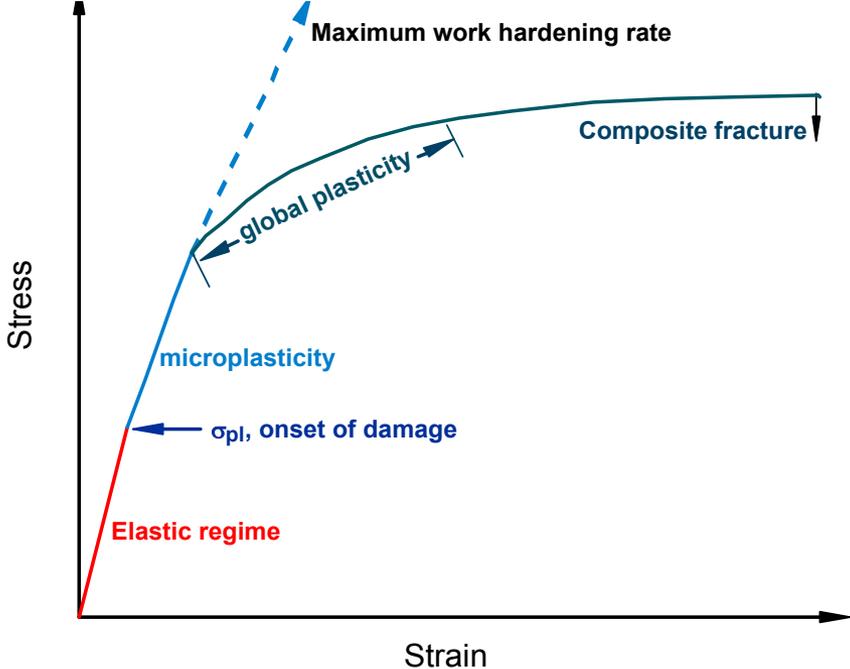
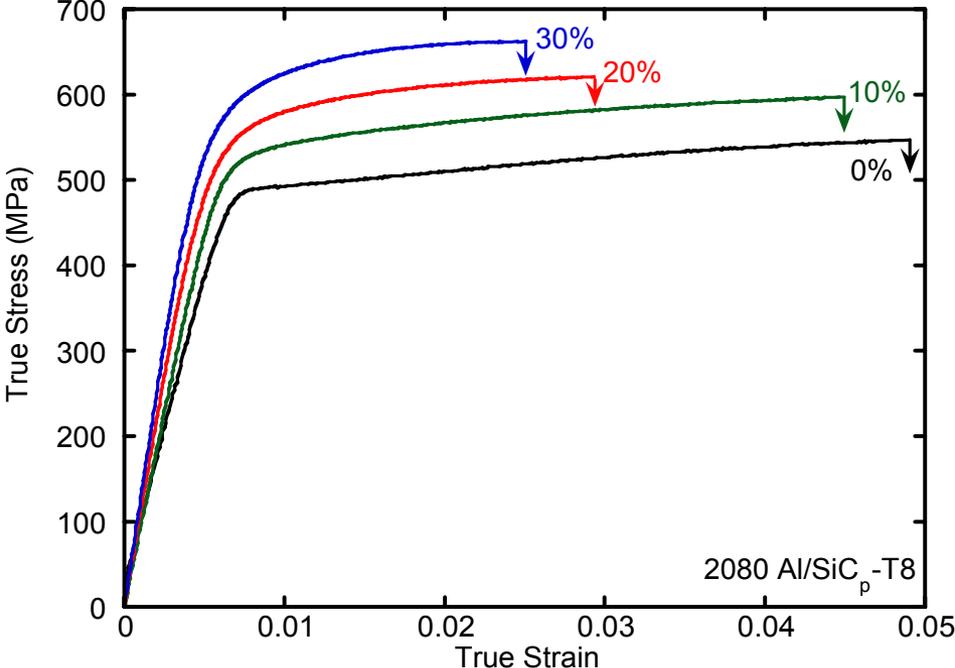
2080/SiC/10_p



100 μm

Extrusion Axis

Ganesh and Chawla,
Metall. Mater. Trans. (2004)



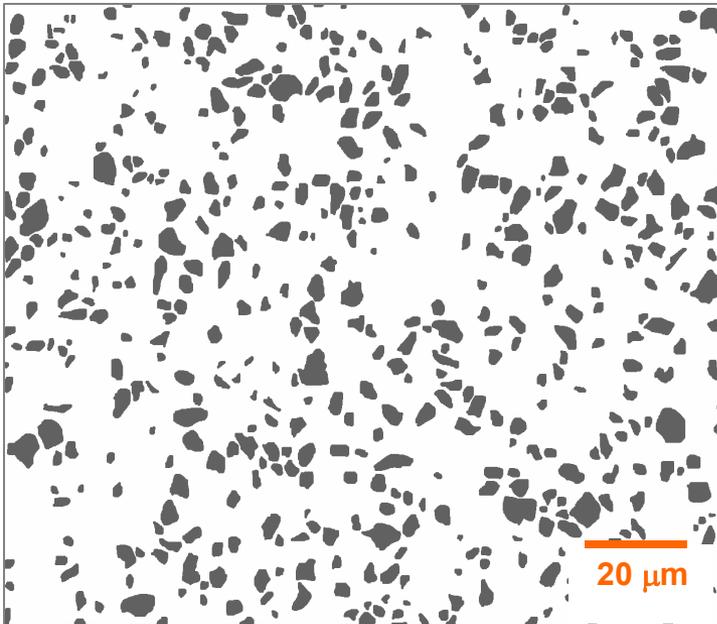
Variation of clustering in Al/SiC/15p

- Clustering was controlled by processing composites with varying Al:SiC particle size ratio
 - Blended, pressed and sintered
- Increasing the Al:SiC particle size ratio resulted in a greater degree of SiC clustering

Homogenous distribution

$$D_{50}^{Al} = 7\mu m \quad D_{50}^{SiC} = 5\mu m$$

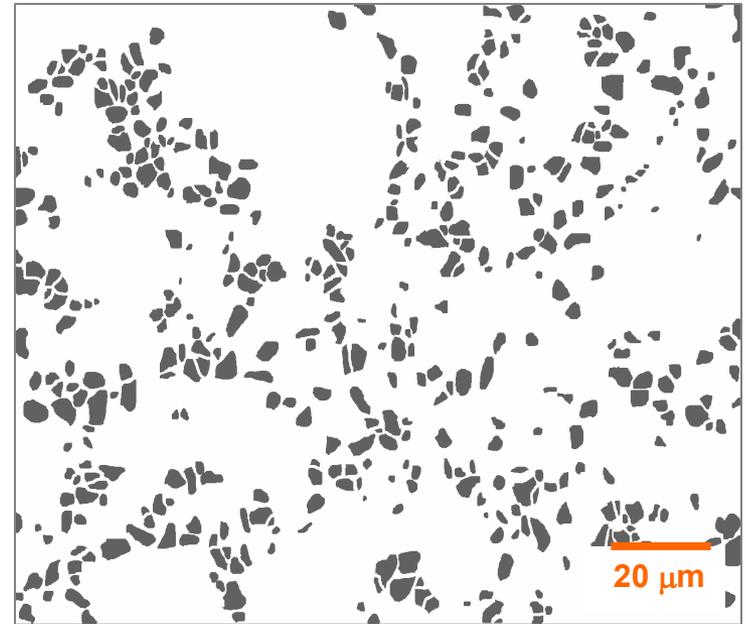
Ratio = 1.4



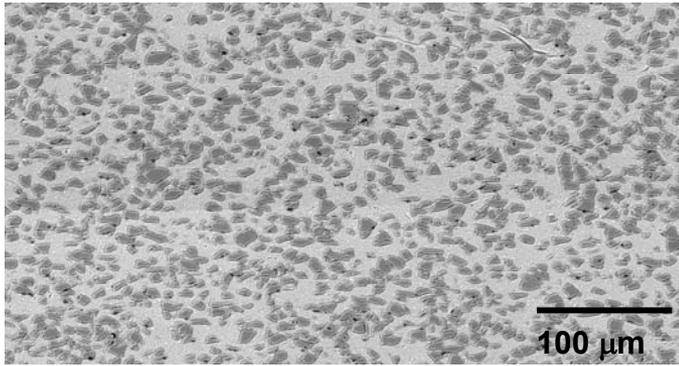
Clustered distribution

$$D_{50}^{Al} = 33\mu m \quad D_{50}^{SiC} = 5\mu m$$

Ratio = 6.6

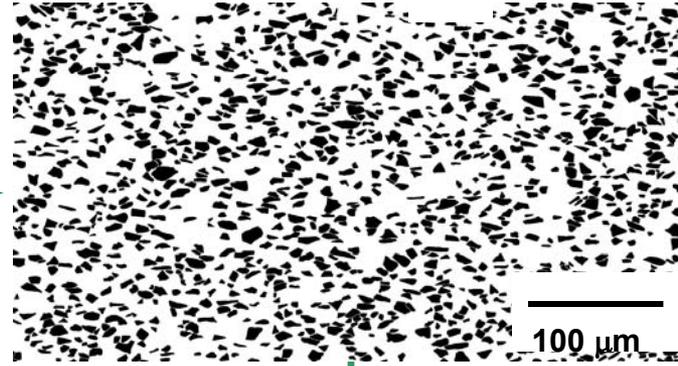


Incorporating actual microstructure into FEM



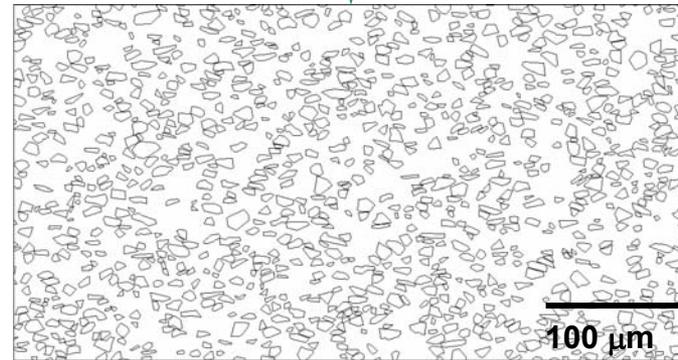
Original SEM Image

ImageJ



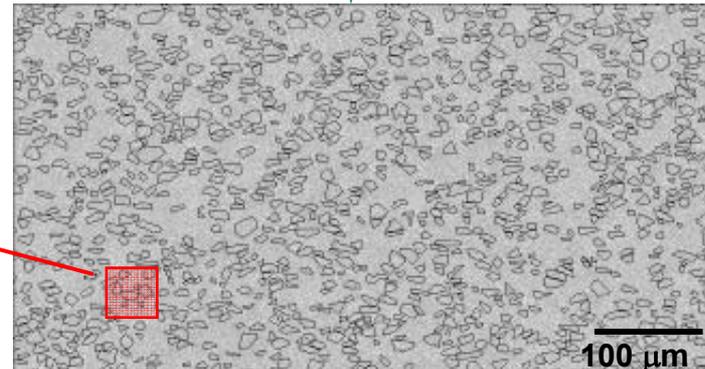
Segmented Image

RasterVect



Vector Image

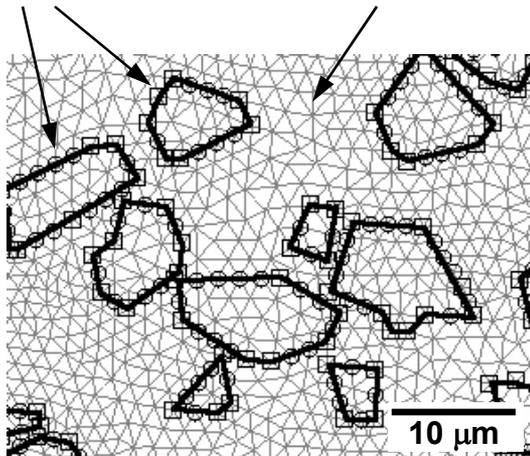
Abaqus, HyperMesh



Meshed Microstructure

SiC Particle

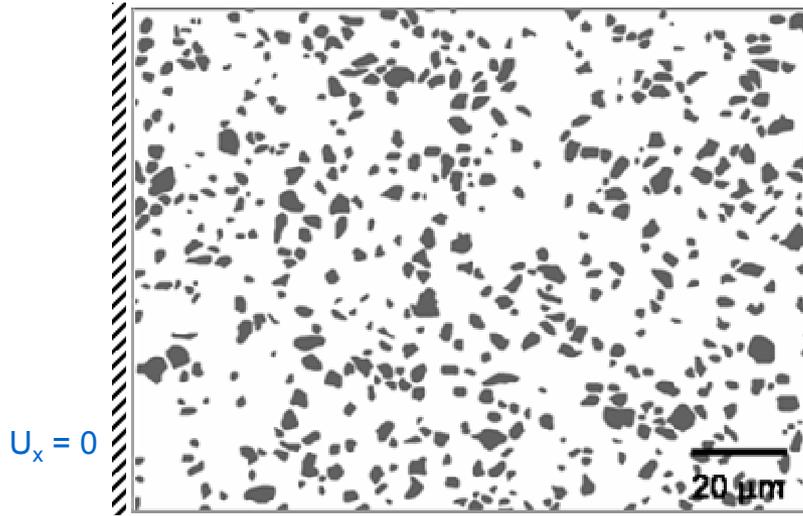
Al Alloy 2080-T6



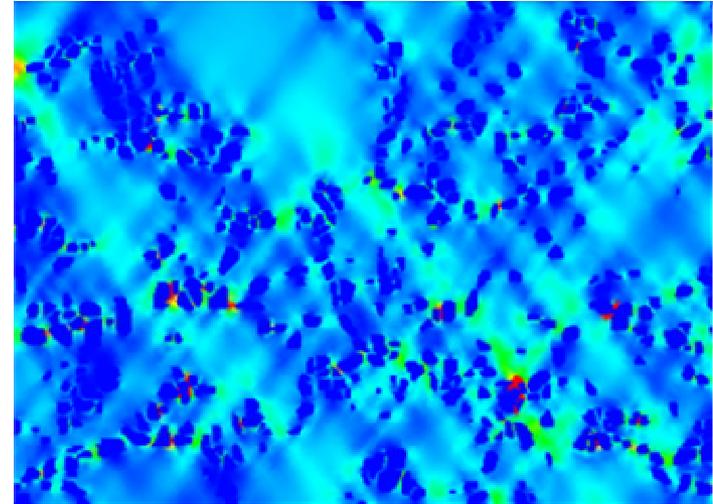
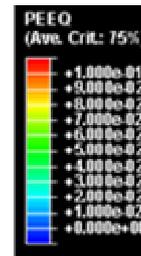
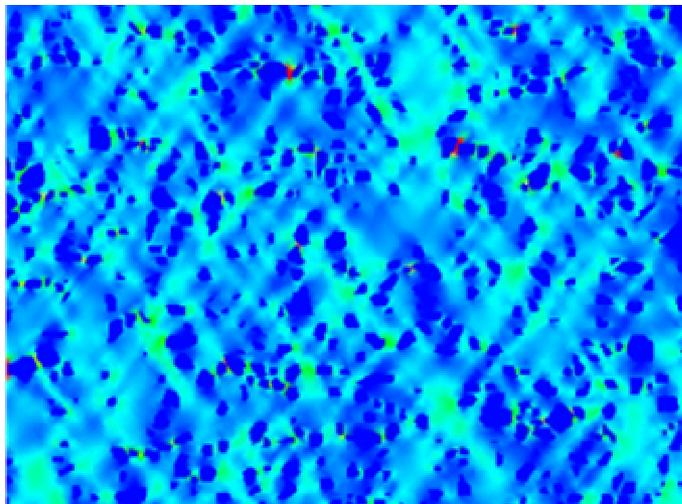
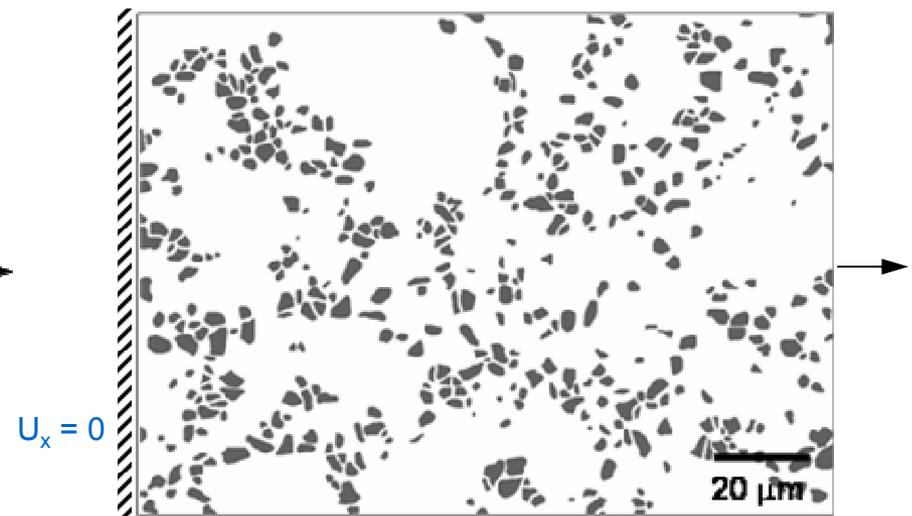
Effect of SiC particle clustering on local strain state

Elastic – plastic analysis

Ratio = 1.4, COV = 0.38

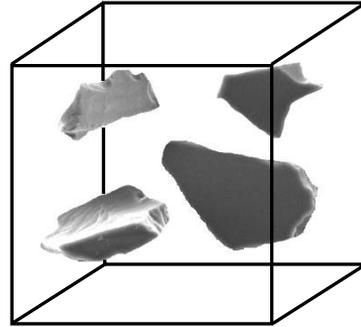


Ratio = 6.6, COV = 0.61



Need for 3D modeling

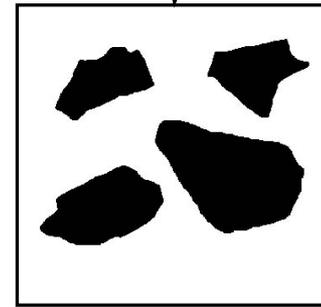
Microstructure



Microstructure-based approach

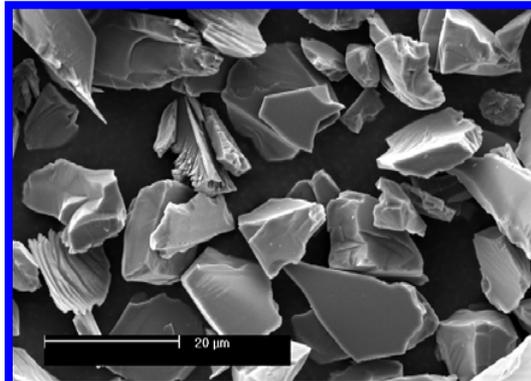
2D analysis is either plane stress or plane strain

SiC particles modeled as “discs” in 2D analysis

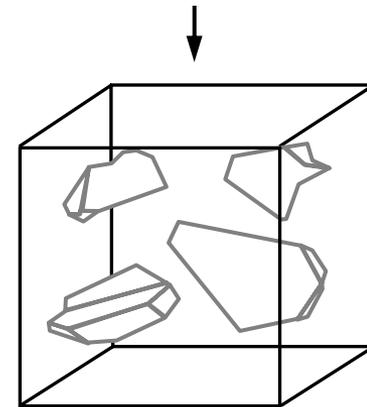


2D Microstructure Model

SiC particles have complex geometry

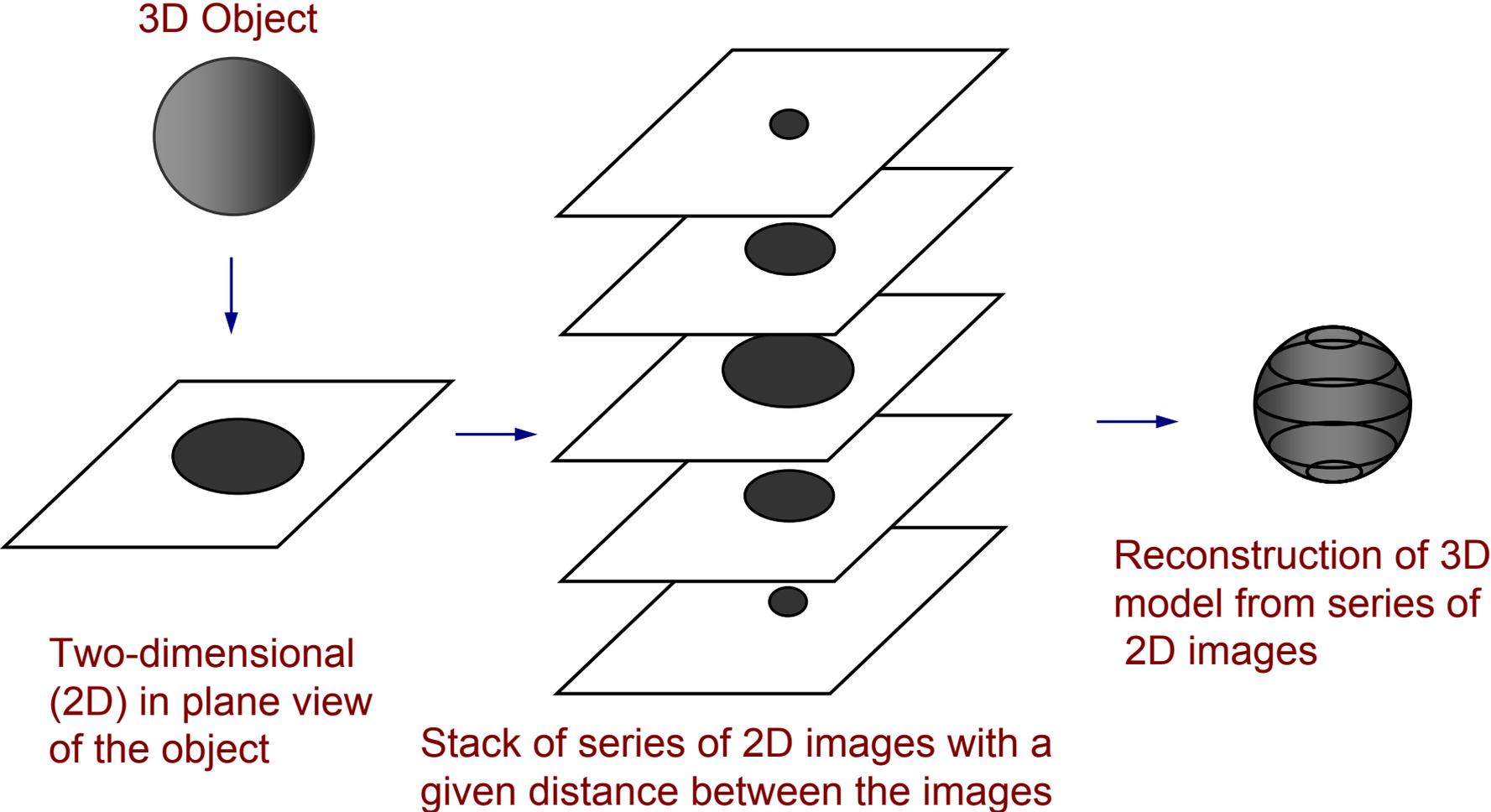


Courtesy of A. Drake, St. Gobain Corp.

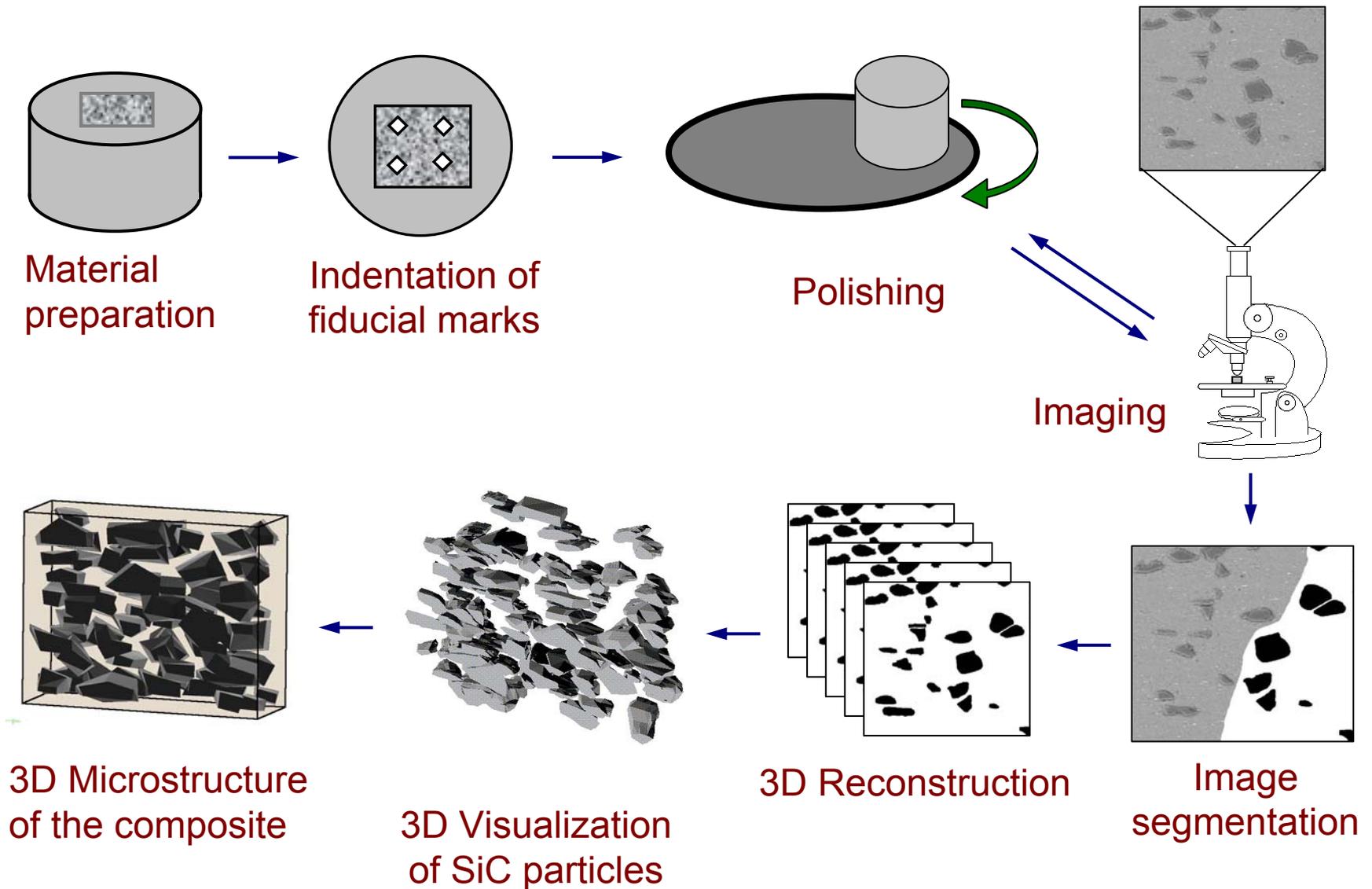


3D Microstructure Model

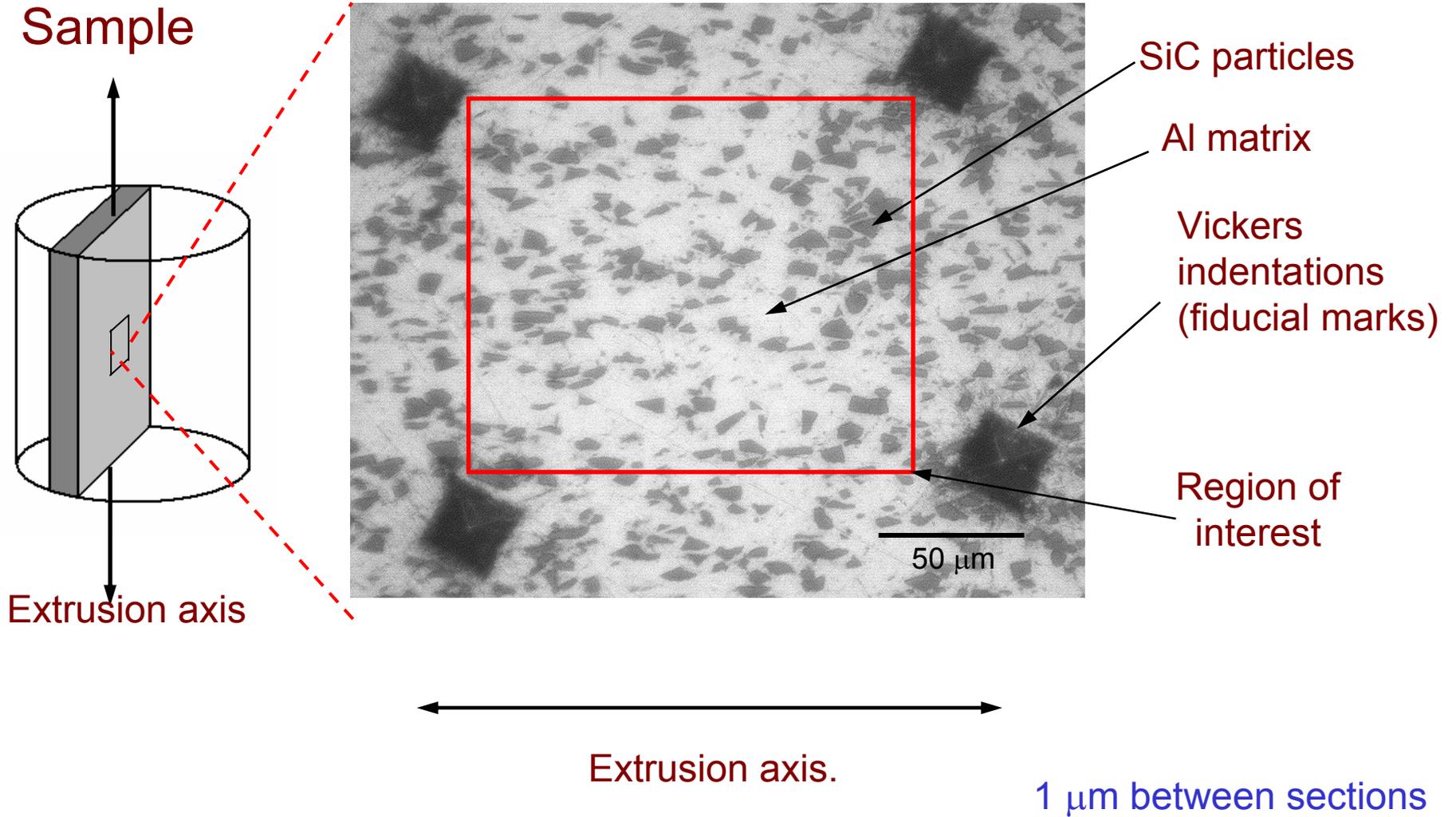
Serial sectioning concept



Serial sectioning process flow chart



Serial sectioning process – Region of interest



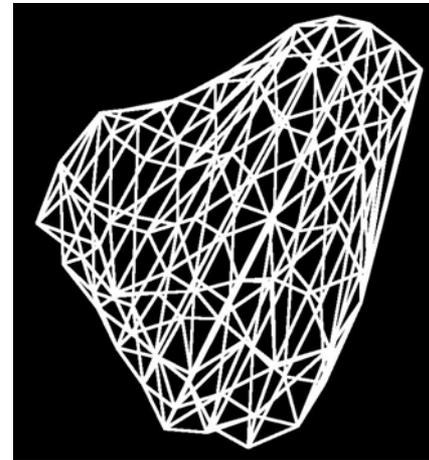
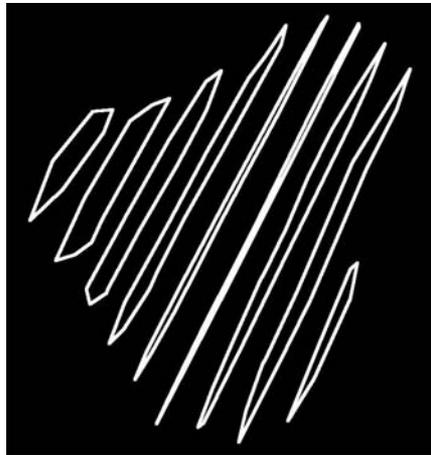
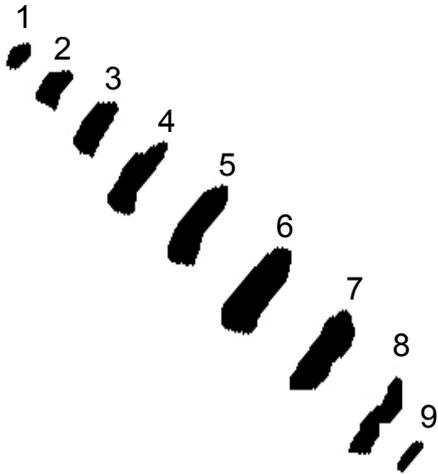
3D reconstruction and visualization

2D serial sections stacked on top of each other

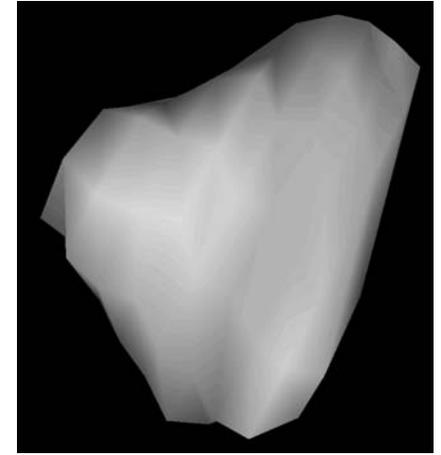
Contour added around the particle in each sections

A surfacing process connects the contours to generate 3D object

3D Object

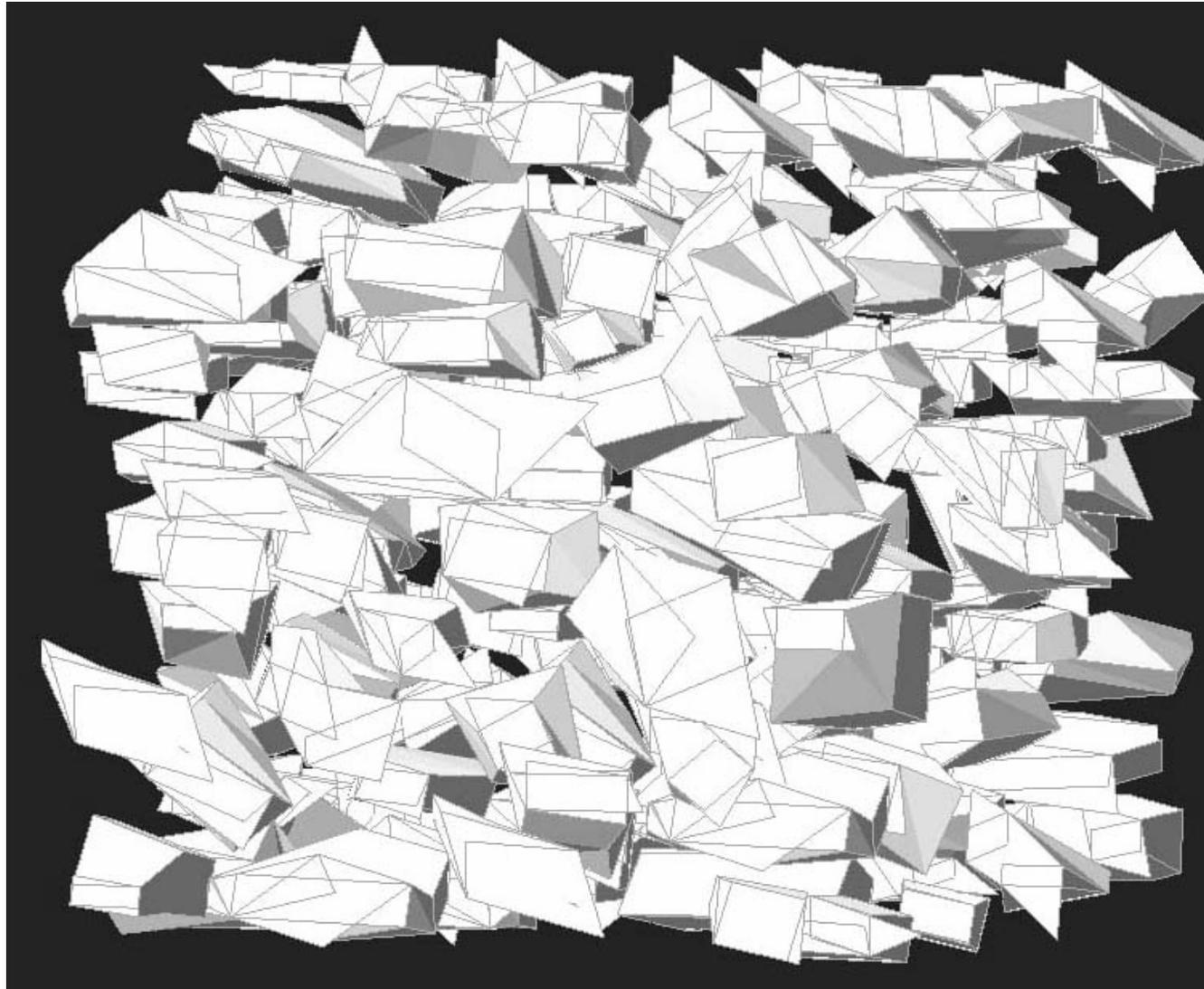


Wire frame view



Full texture view

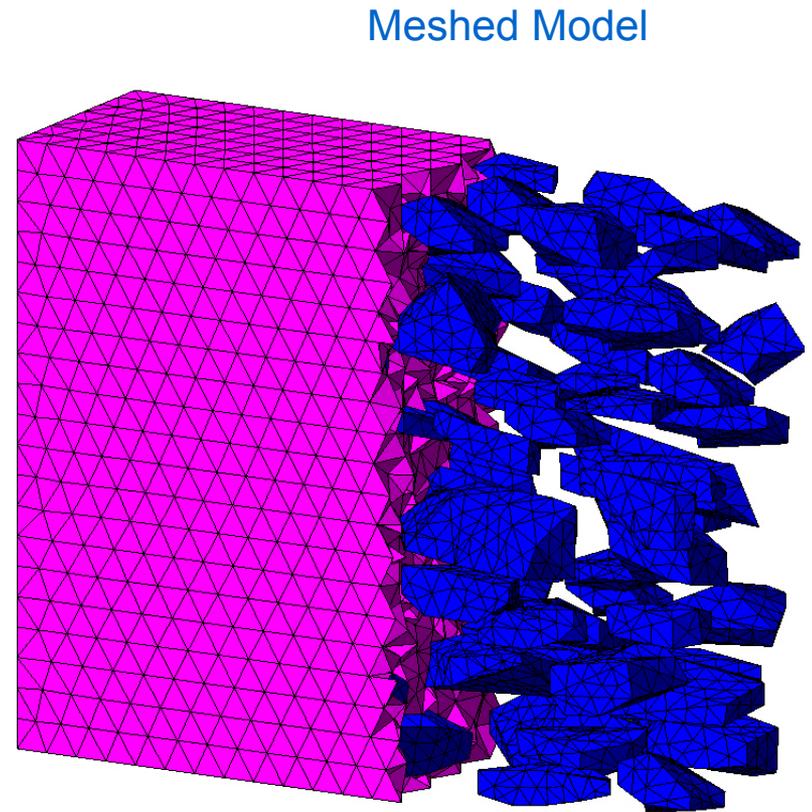
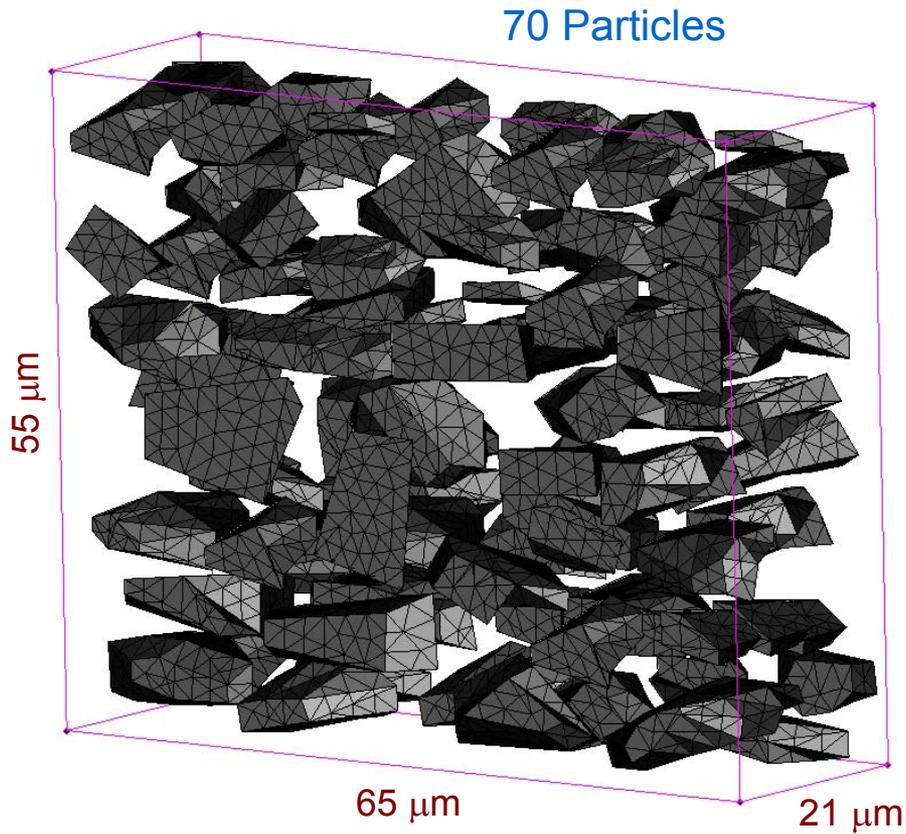
3D Microstructure visualization - 2080/SiC/20_p



10 μm

Incorporating 3D model into FEM analysis

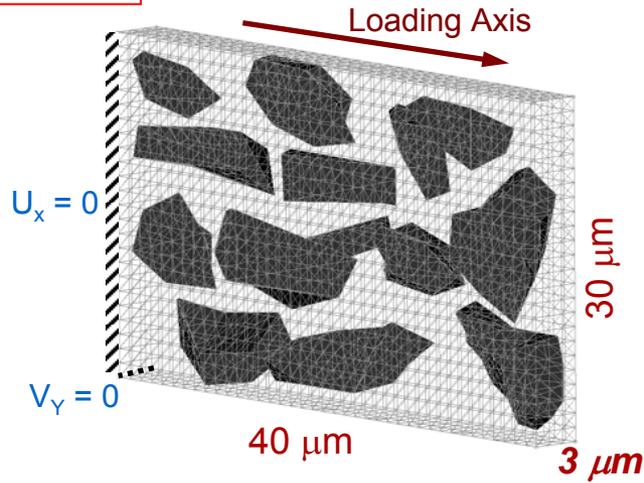
- The particles are imported into HyperMesh® and the matrix geometry is created.
- The model is then meshed and exported to ABAQUS for analysis



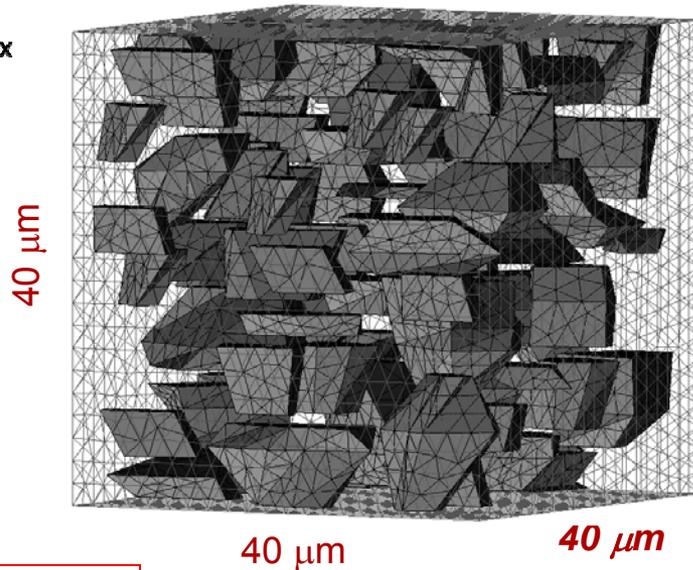
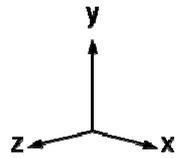
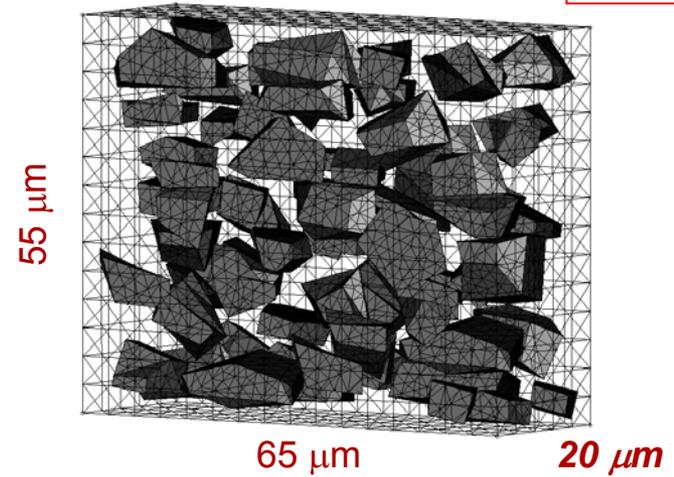
10 node Tetrahedral elements

Effect of model size (Thickness)

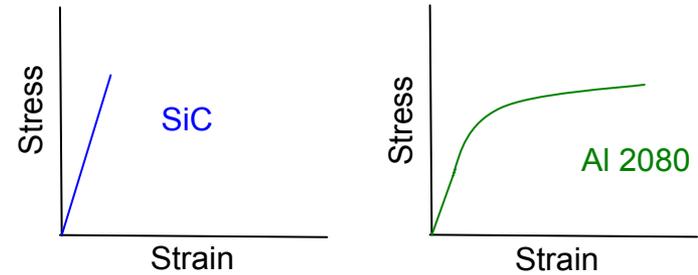
3 μm Model



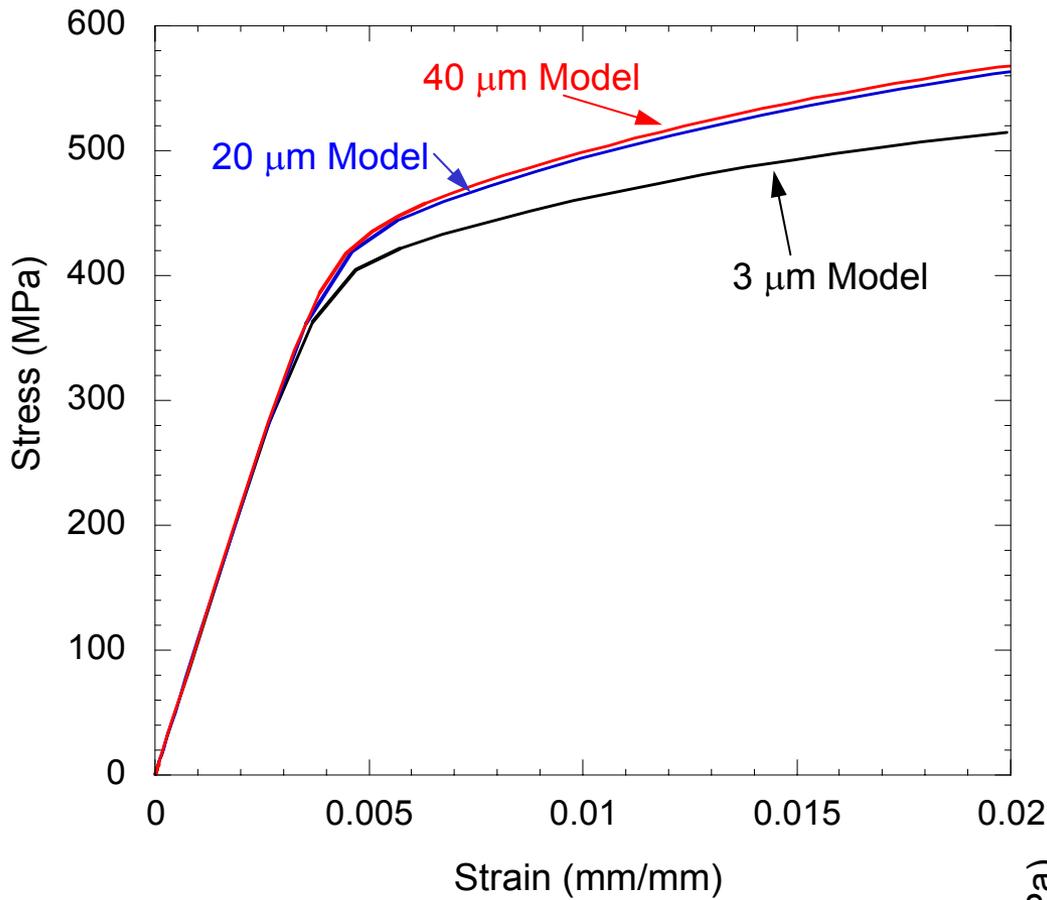
20 μm Model



40 μm Model



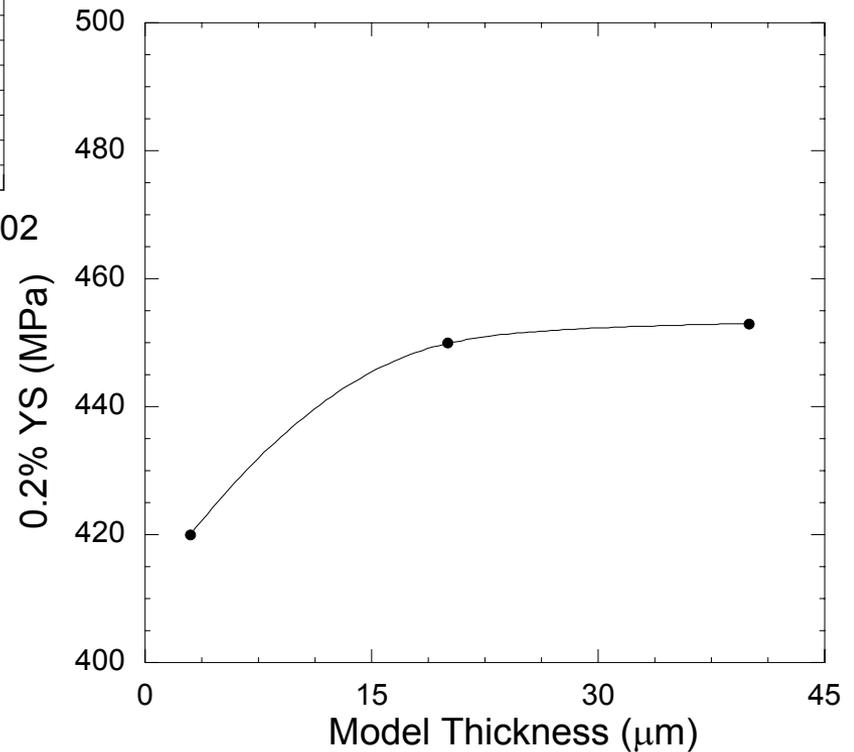
Material	Elastic Modulus (GPa)	Poisson's Ratio
Al	74	0.33
SiC	410	0.19



20 μm model was chosen as the representative volume

Effect of model size

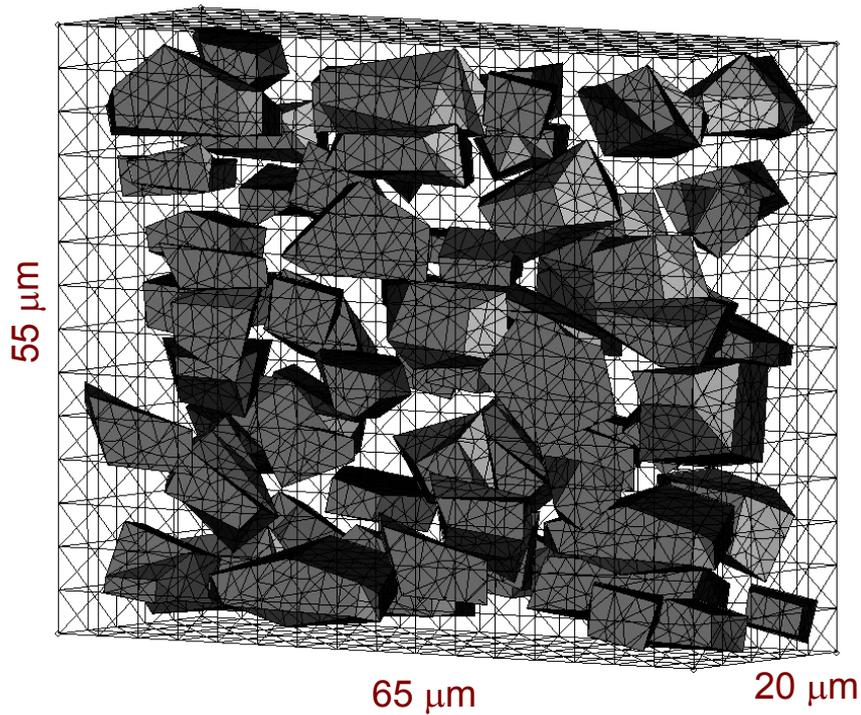
Model	E (GPa)
3 μm	107
20 μm	107.5
40 μm	107.8



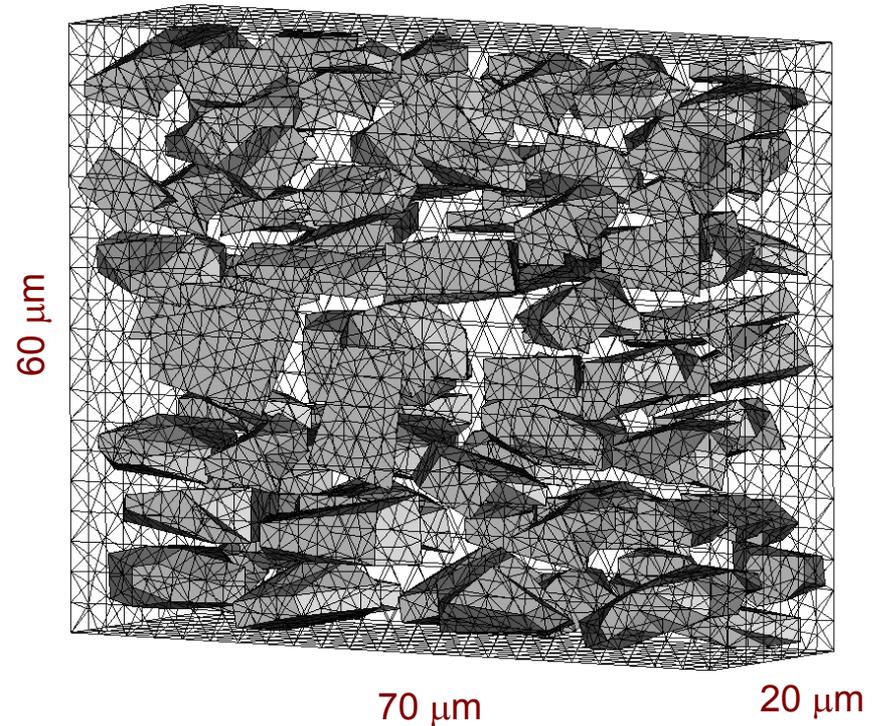
Microstructure variability

Simulation was carried out on two models created from different regions to validate the approach

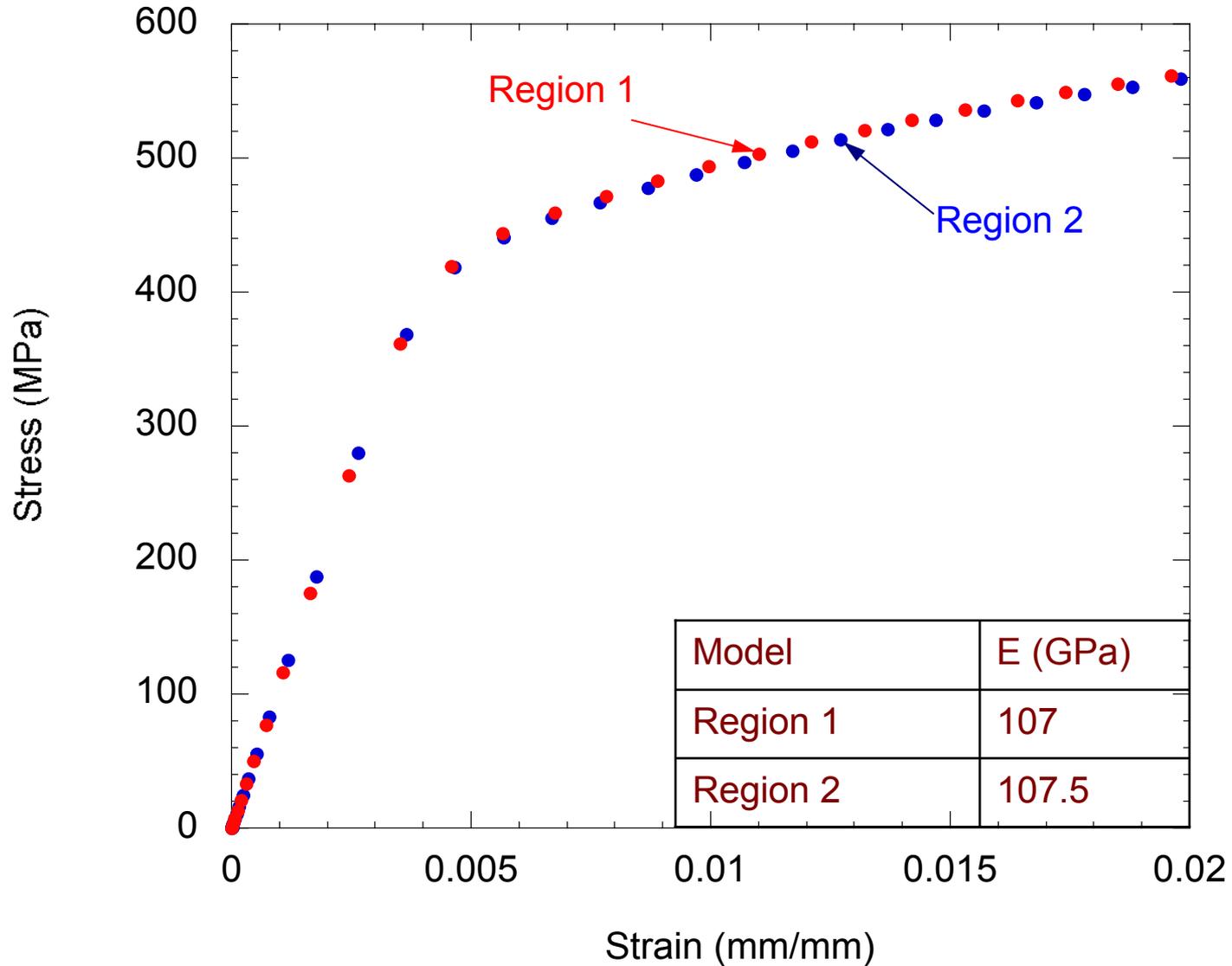
Region 1



Region 2



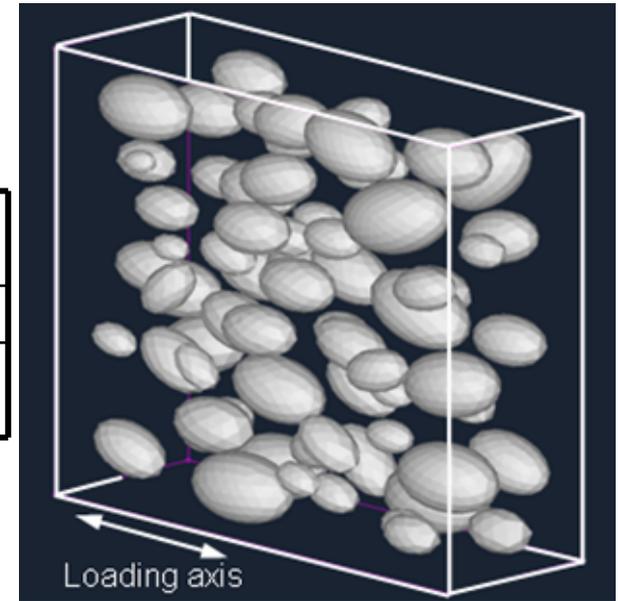
Microstructure variability



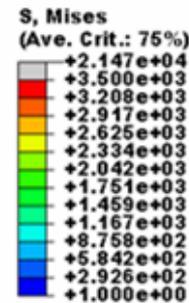
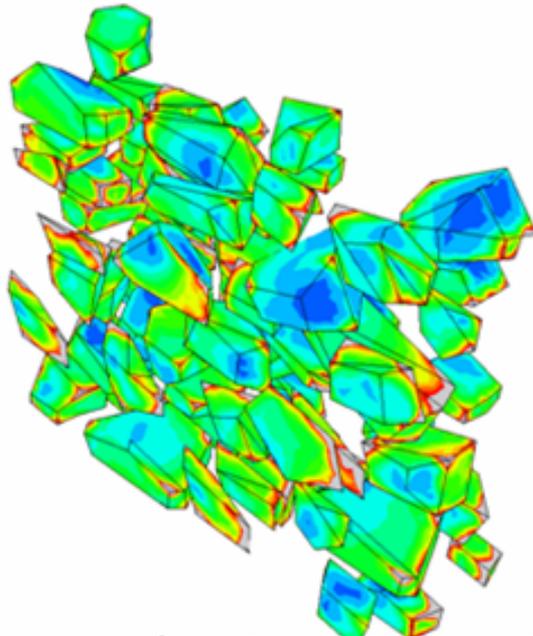
Effect of simplifying particle geometry



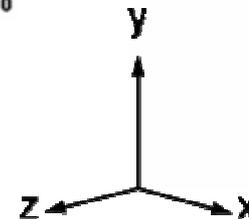
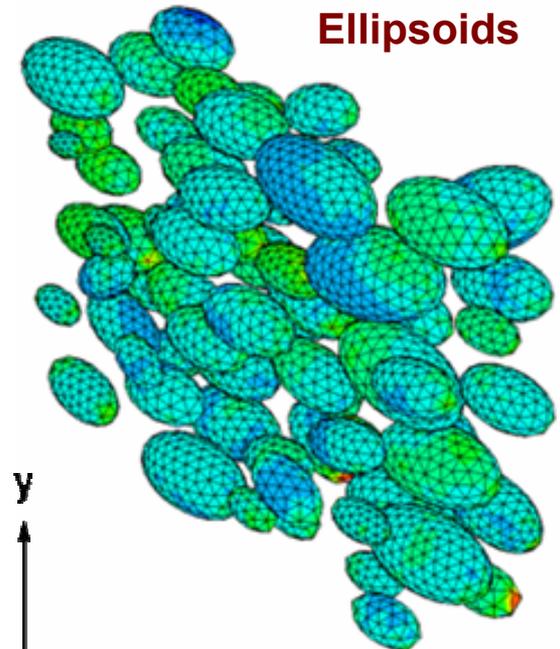
Model	No. of Elements	Hours
3D Ellipsoidal	87323	25
3D Microstructure	89128	26



Microstructure



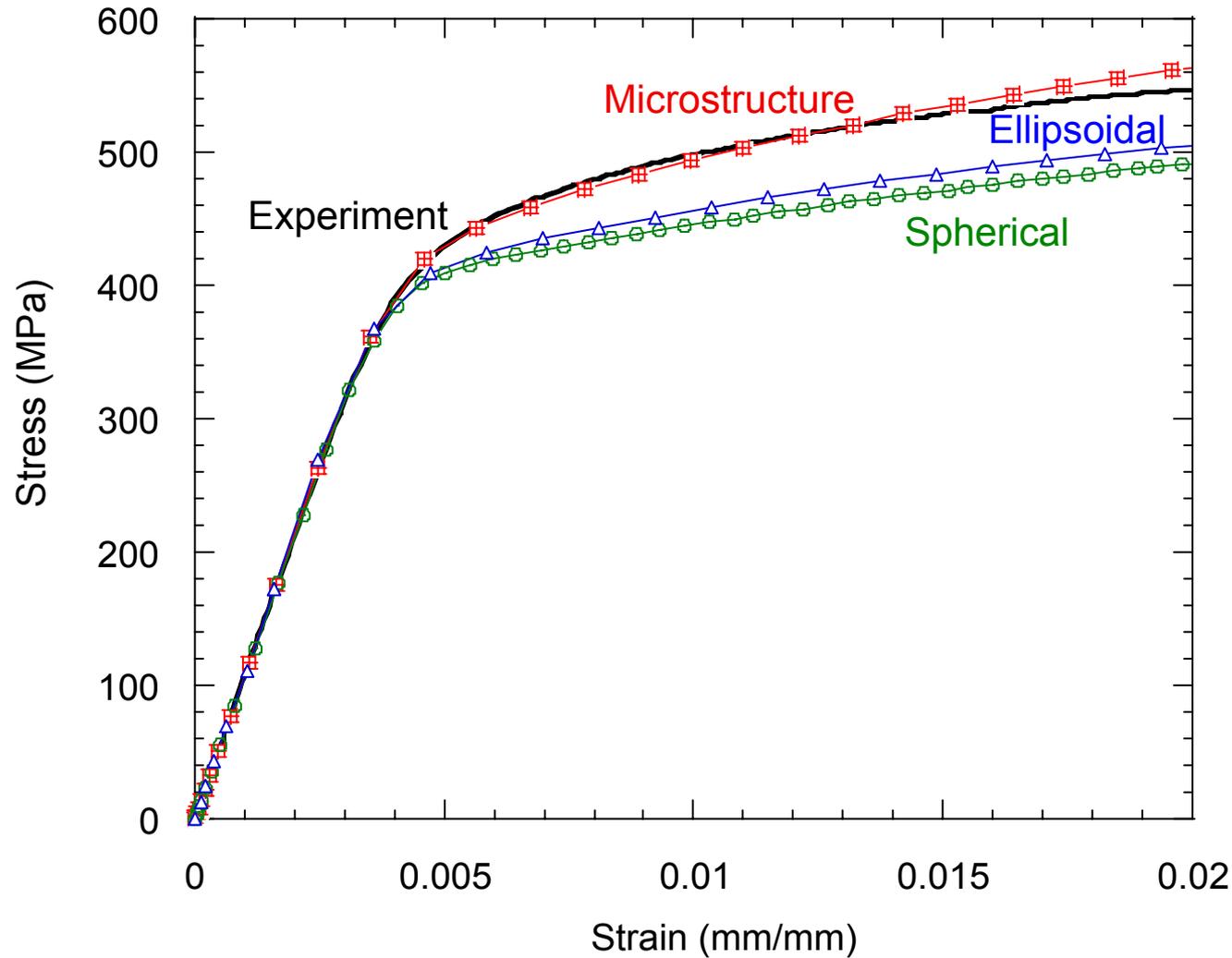
Ellipsoids



N. Chawla, R.S. Sidhu, and V.V. Ganesh, *Acta Mater.*, (2006).

N. Chawla and K.K. Chawla, *J. Mater. Sci. – 40th Ann. (1966-2006)*, (2006).

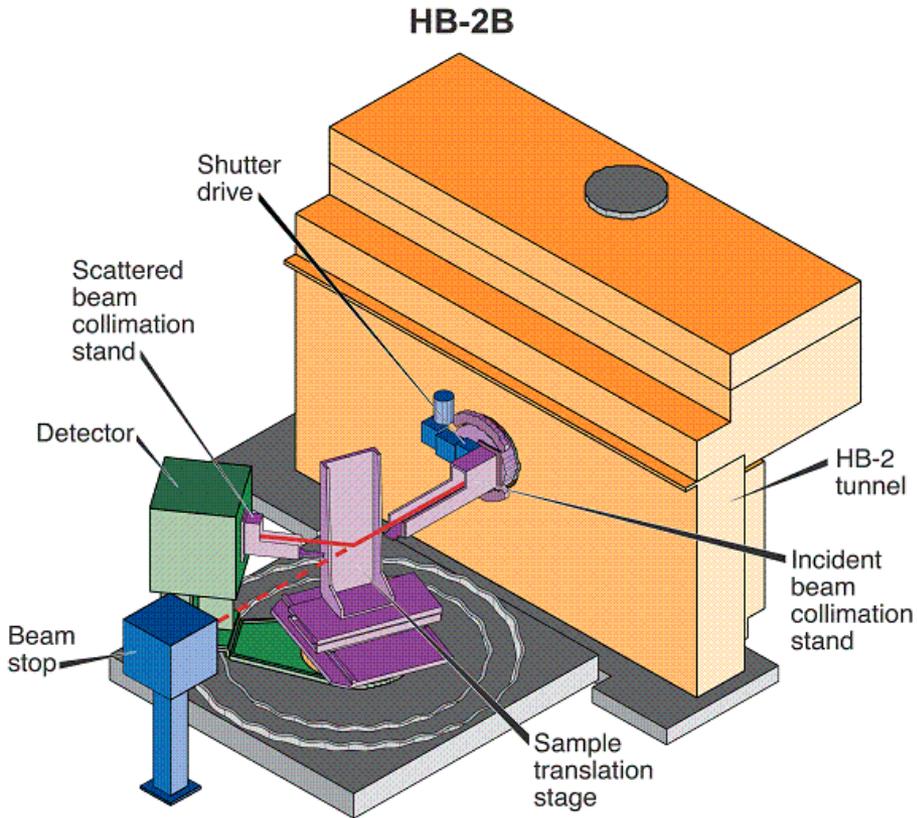
Comparison of microstructure-based model with conventional models and experiment



N. Chawla, R.S. Sidhu, and V.V. Ganesh, *Acta Mater.*, (2006).

N. Chawla and K.K. Chawla, *J. Mater. Sci. – 40th Ann. (1966-2006)*, (2006).

Experimental verification of internal strain/stress by neutron diffraction



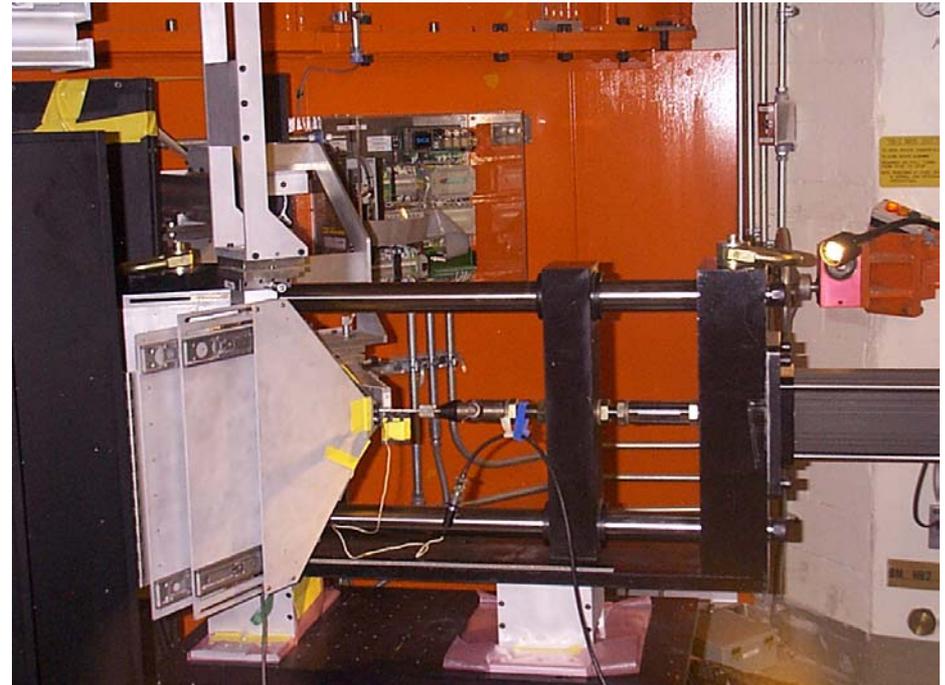
Monochromator: 1.452,
1.731, 1.886, 2.275 Å

Detector Angel: 30-150°

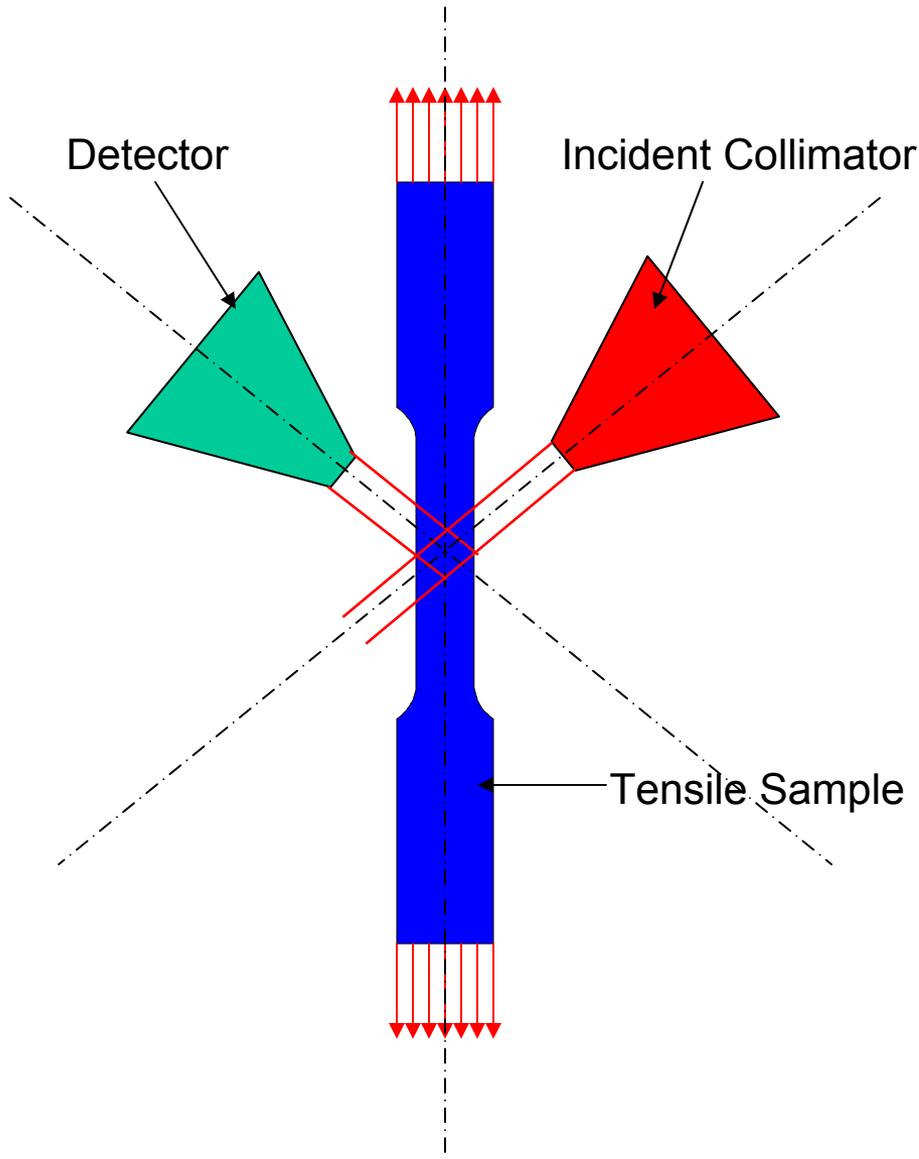
Detection System: 7 Position-
Sensitive Detectors

Detector Resolution: 1.8 mm

<http://neutrons.ornl.gov/>



Measurement of internal strains during tensile test



Diffraction Peak: Al (311), SiC (116)

Monochromator: 1.729567 Å

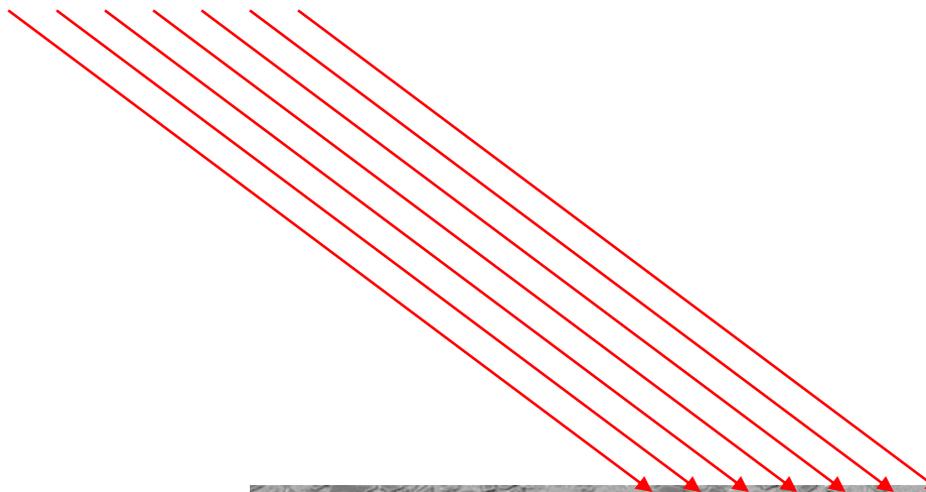
Gauge Volume: 5×5×5 mm

Displacement Control Rate: 0.0005 mm/s

Displacement Step Size: 0.02 mm

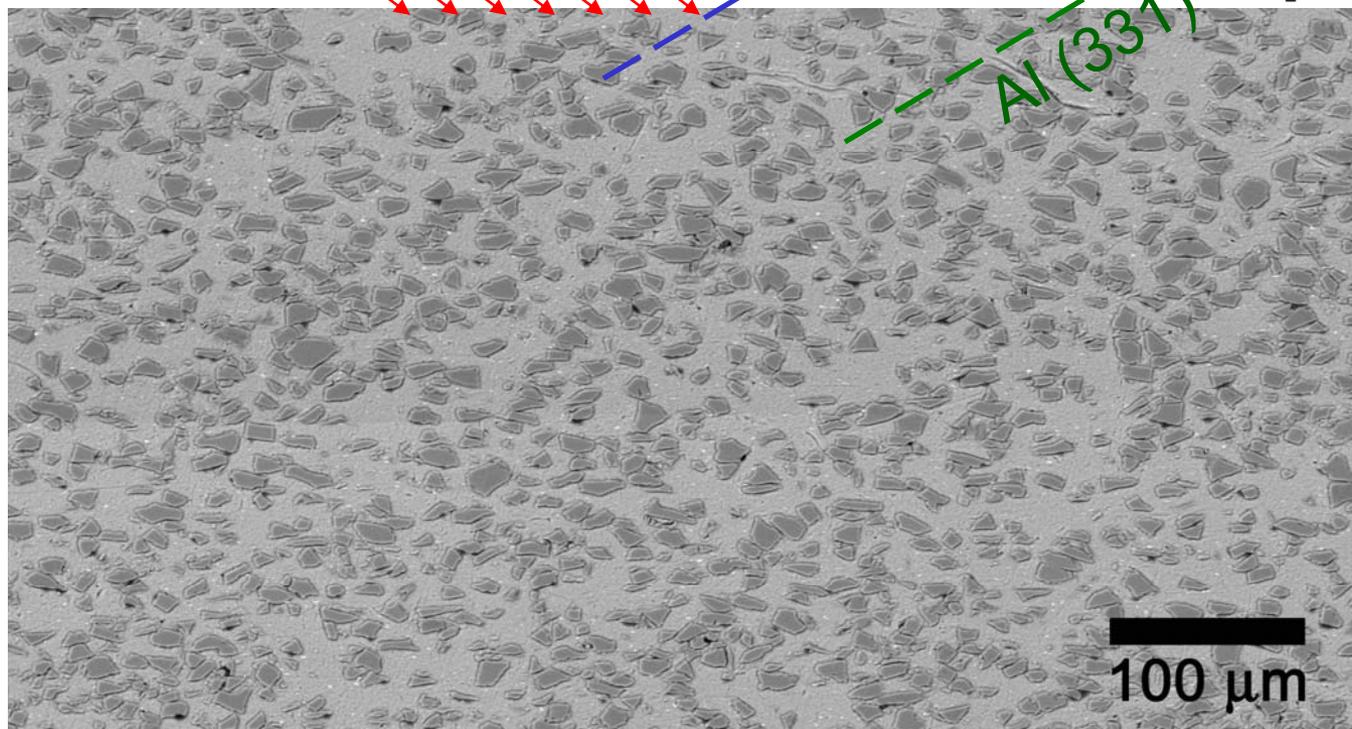
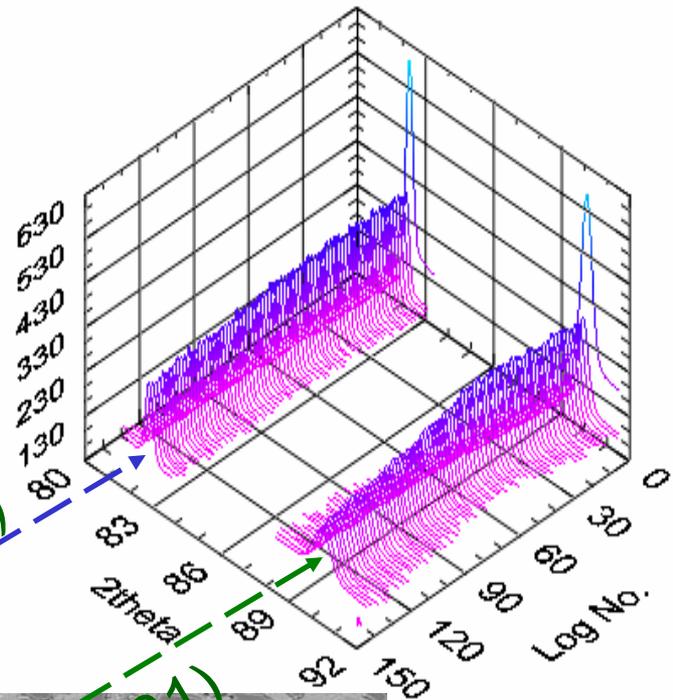
Diffraction Acquisition Time: Al-8 minutes,
SiC-4 minutes

Incident beam

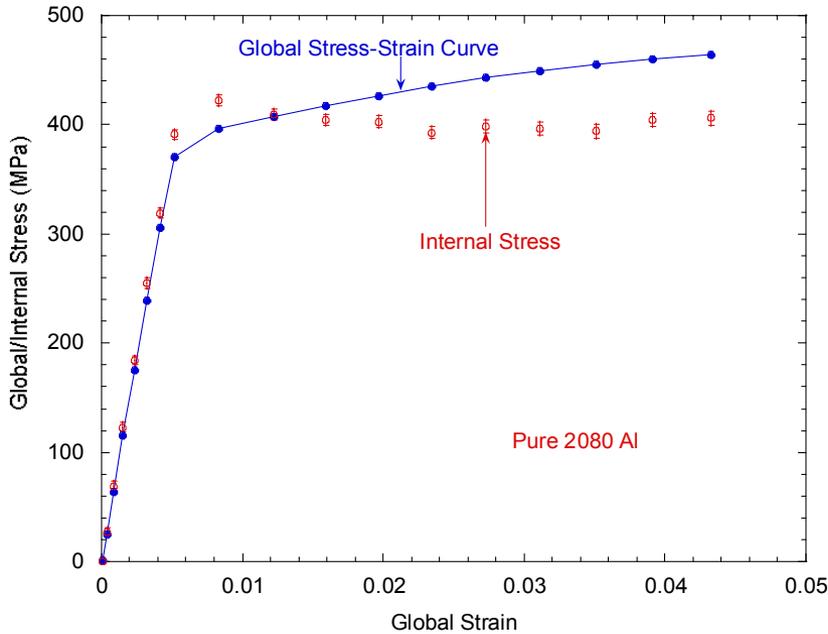


SiC (116)

Al (331)

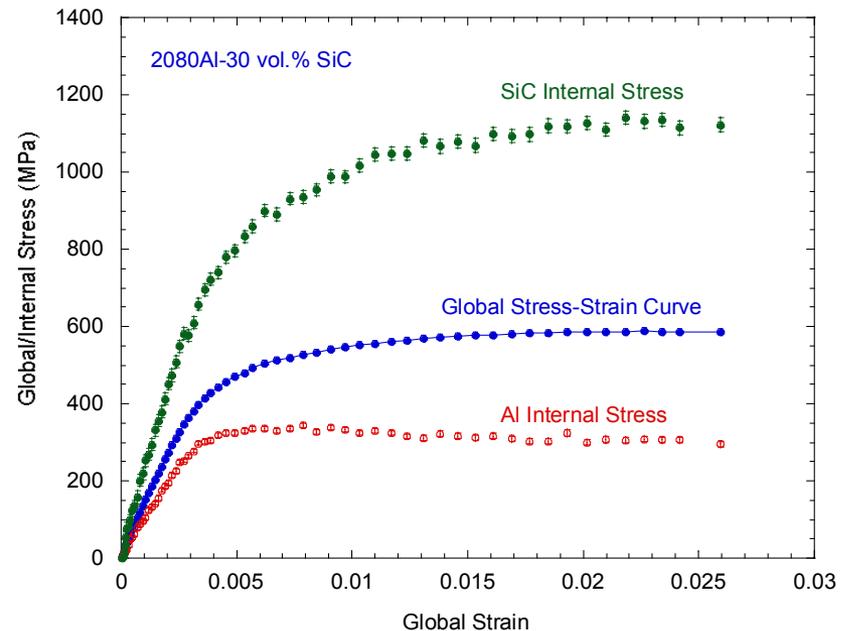
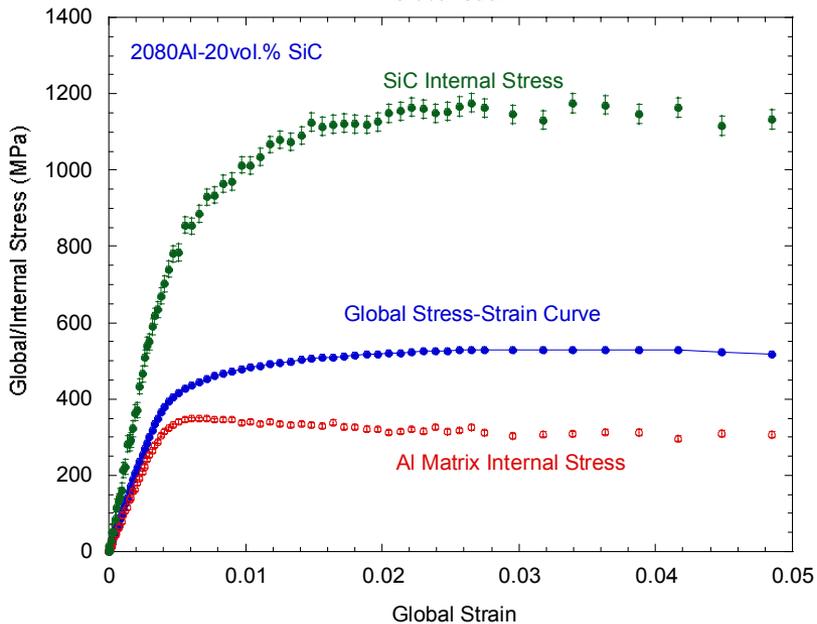


Comparison of global stress and internal stress during tensile testing

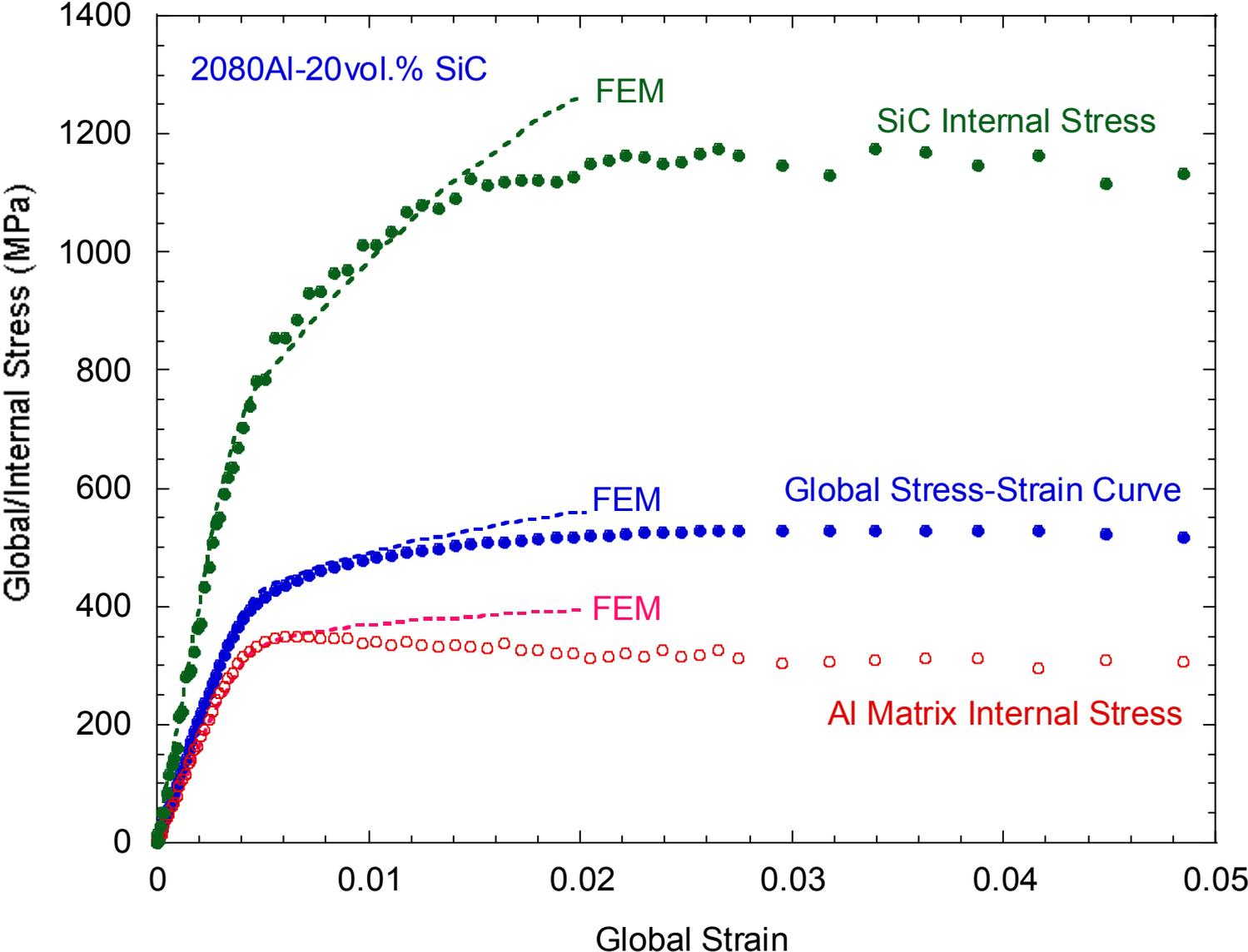


Internal stress of Al matrix and SiC particle was measured by neutron diffraction.

Strains were calculated by changes in lattice spacing during tensile testing.

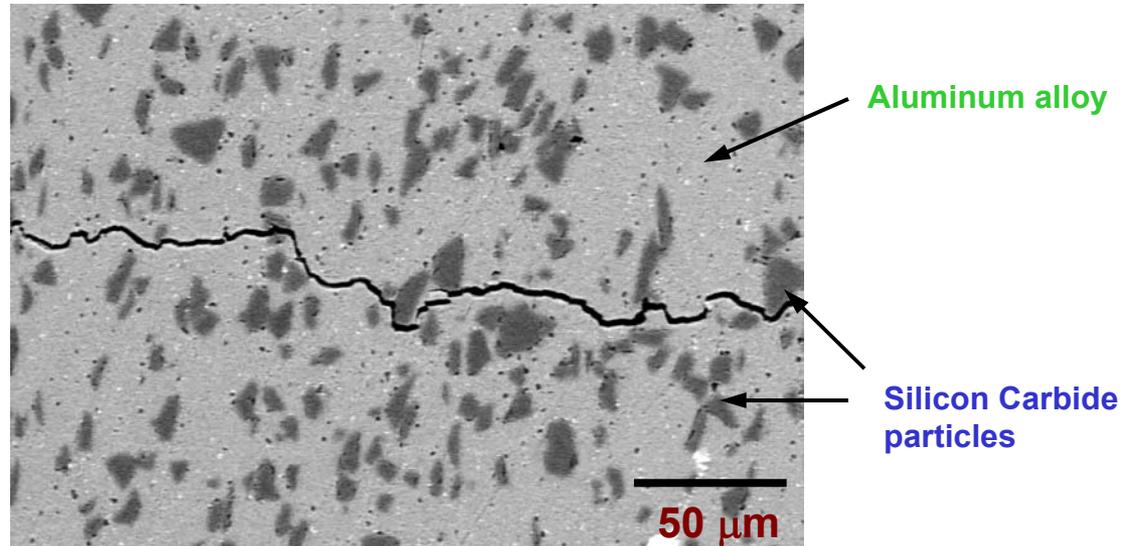


Comparison of microstructure-based FEM predictions of stress/strain partitioning with neutron diffraction measurements



Modeling crack growth in particle reinforced composites

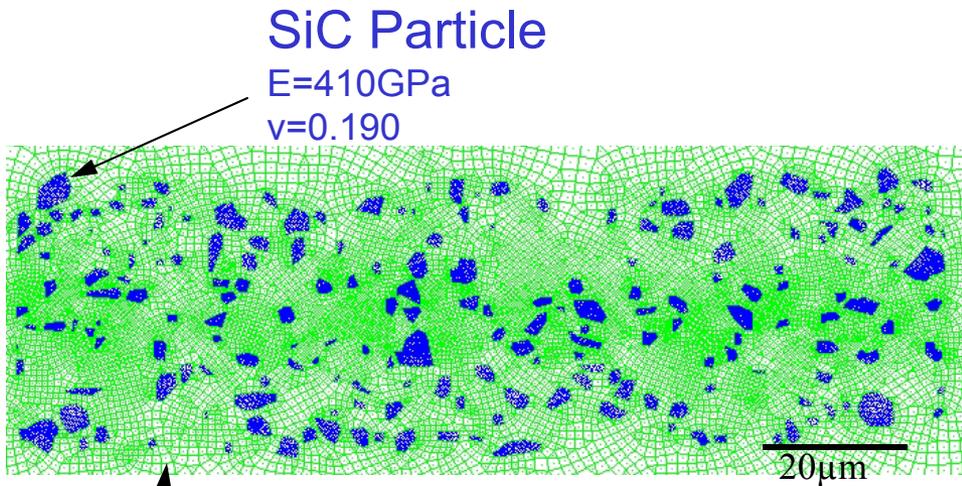
Al/SiC_p system



- FRANC2D/L* was used to model crack growth
- Crack path was not known in advance, hence re-meshing method was used
- Fracture calculations using Linear Elastic Fracture Mechanics (LEFM) principles
 - Stress Intensity Factors that govern the fracture process were calculated using *Modified crack closure method*
 - *Max. Circumferential Tensile Stress theory* was used to determine the crack propagation direction

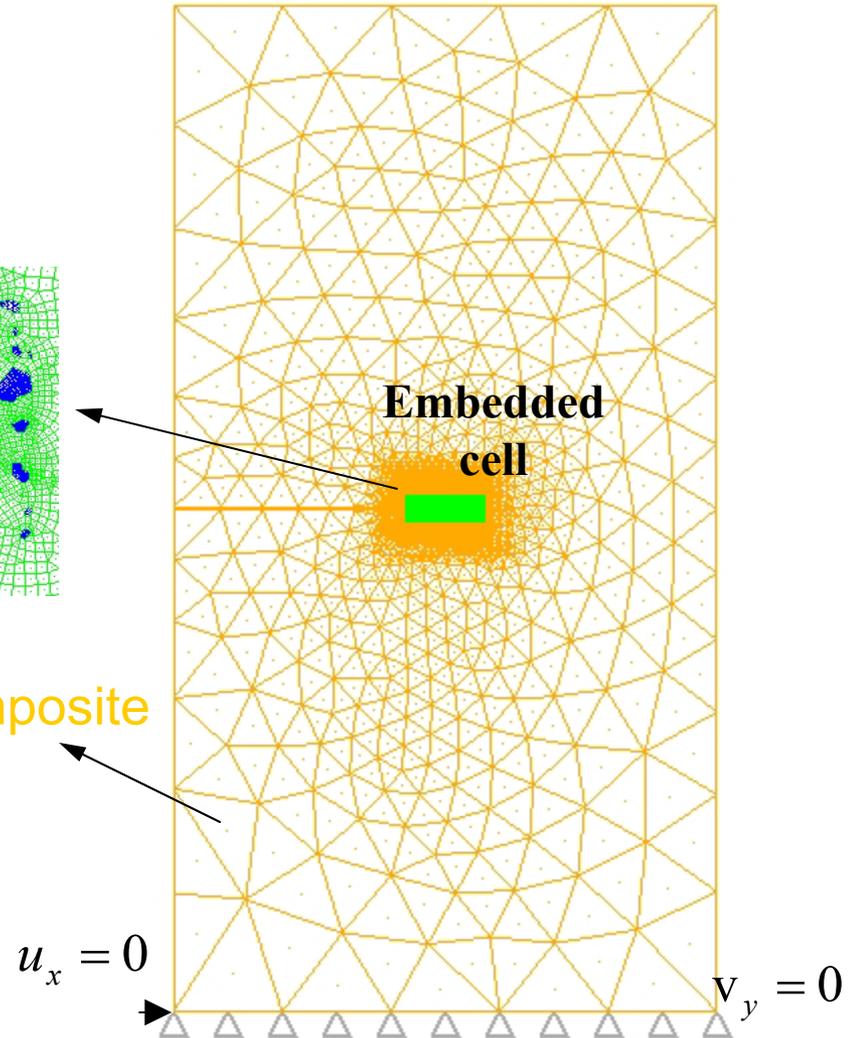
Numerical model description

- Plane stress
- Elements = 18,000; Nodes = 47,000



Al Alloy 2080-T6
E=74GPa
v=0.330

“Average” Composite
2080/SiC/15p – T6
E=98GPa
v=0.309

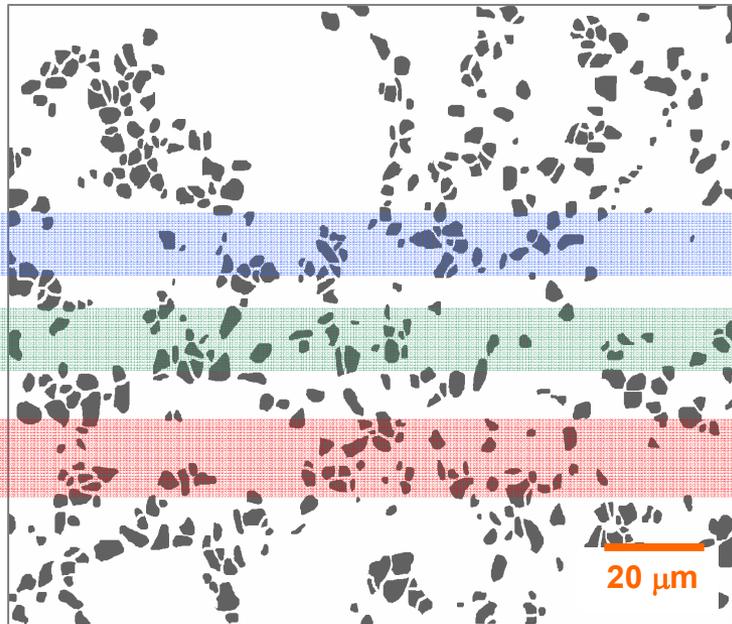


Simulated crack paths in models with clustered particle distribution

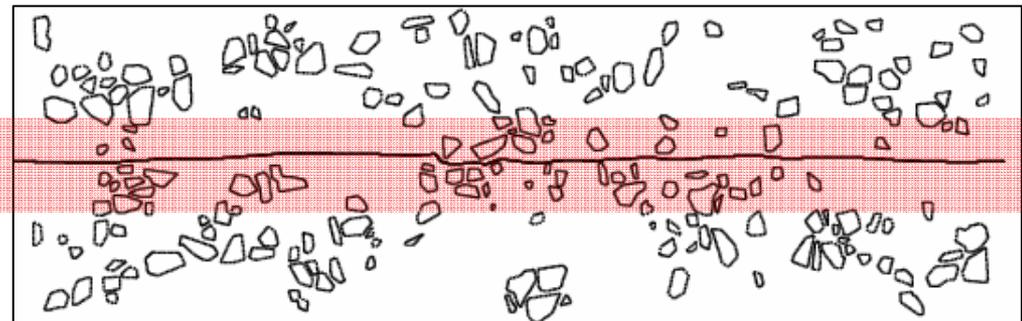
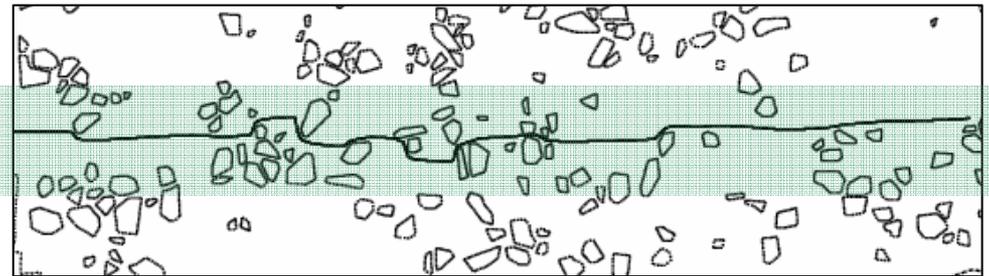
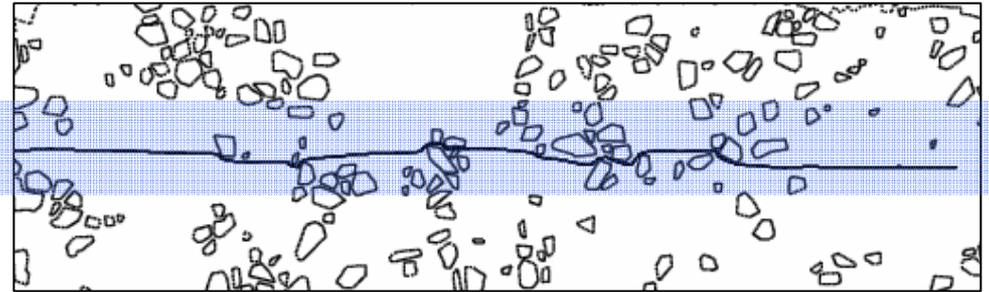
Crack growth direction
→

$$D_{50}^{Al} = 33\ \mu\text{m} \quad D_{50}^{SiC} = 5\ \mu\text{m}$$

Ratio = 6.6

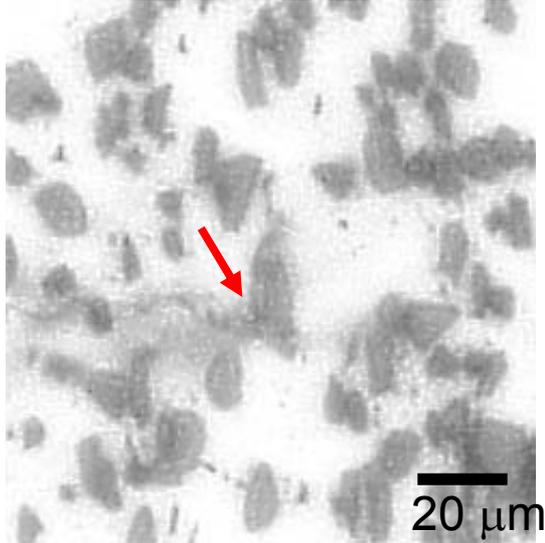


Embedded cells



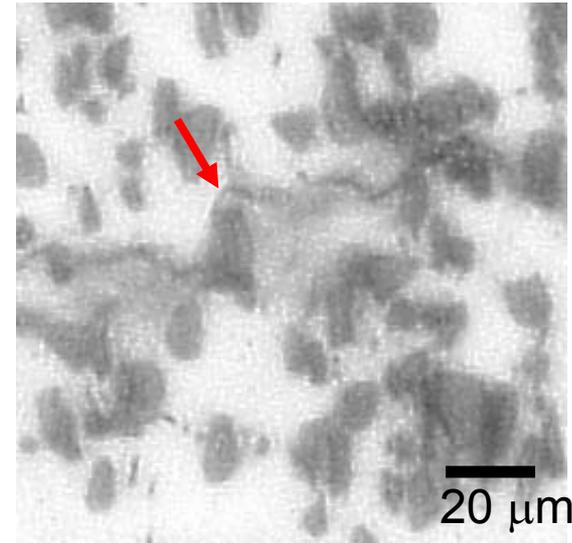
Fatigue crack growth mechanisms at Low/High R-Ratio

Before Crack Growth

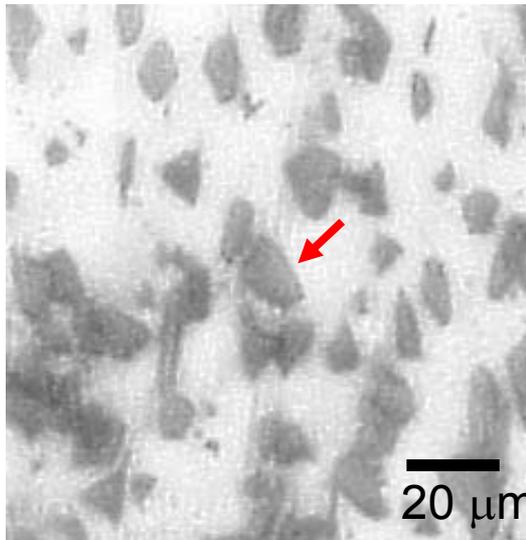


R = 0.1

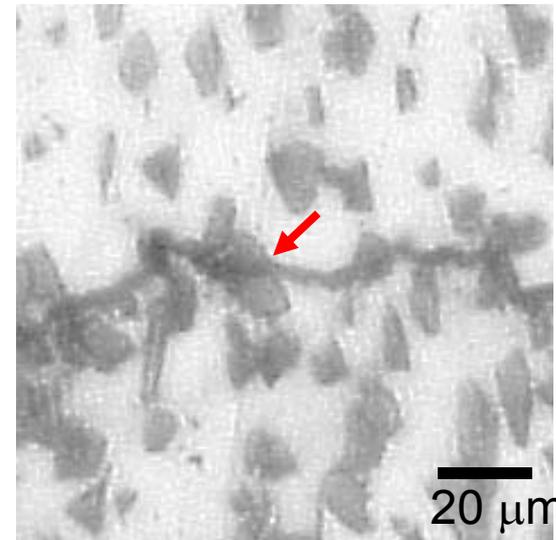
After Crack Growth



Crack growth is observed around the SiC particles.



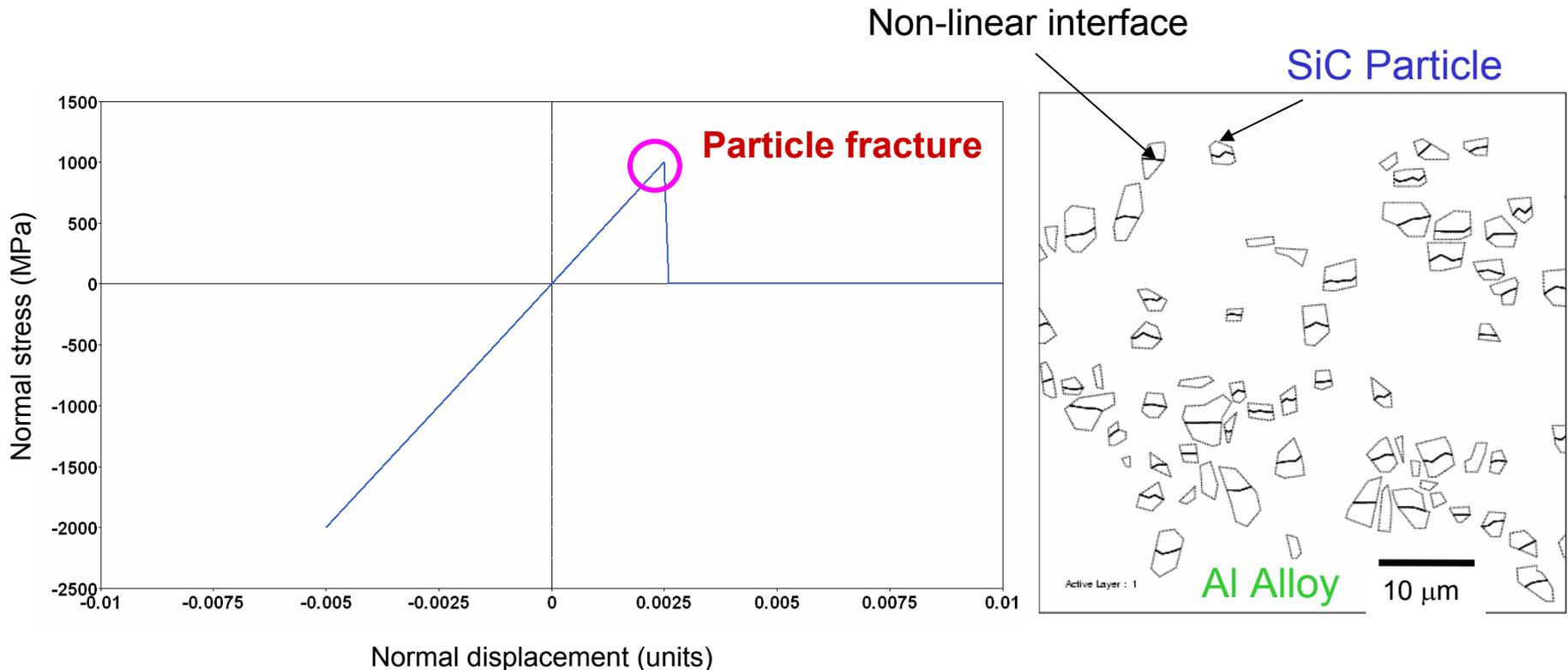
R = 0.8



Crack growth is observed through the SiC particles.

Motivation for modeling reinforcement particle fracture

- Reinforcement particles do not possess infinite strength.
- Regions around a crack-tip are at a high stress state. How does this high stress influence the load bearing capabilities of the particle?
- When particles fracture, how do they influence the crack path and the crack-tip driving force?

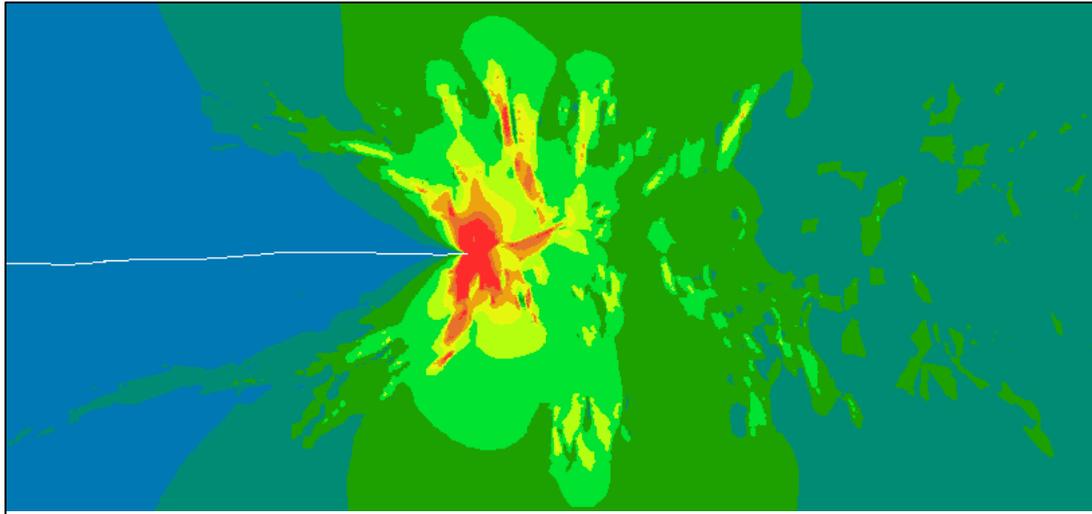


Crack propagation with particle fracture

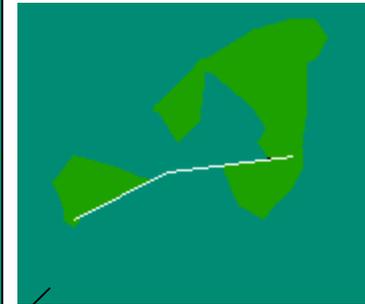
Crack growth
direction
→

Von Mises stress contours at applied stress of **48** MPa

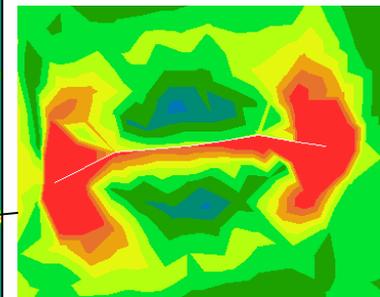
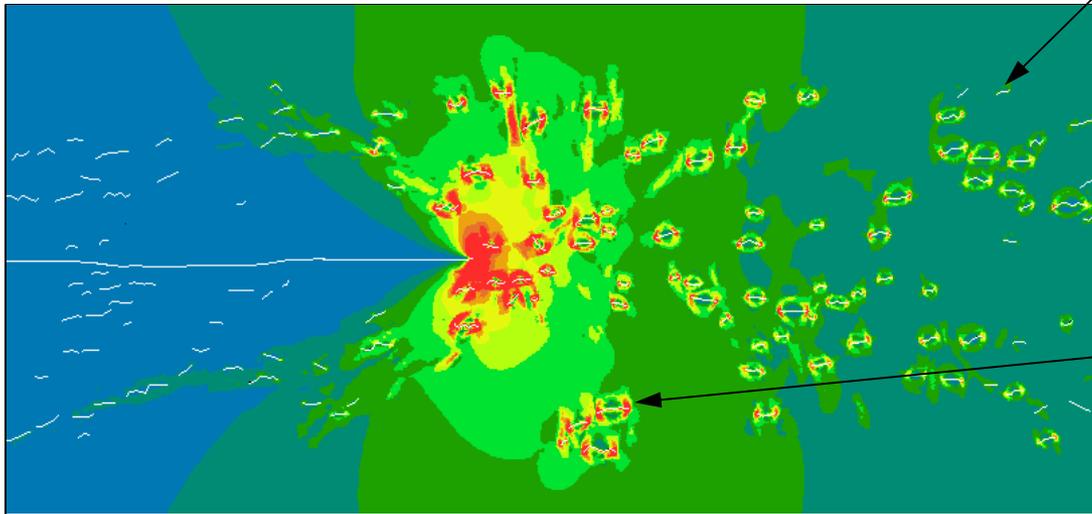
*No particle
fracture*



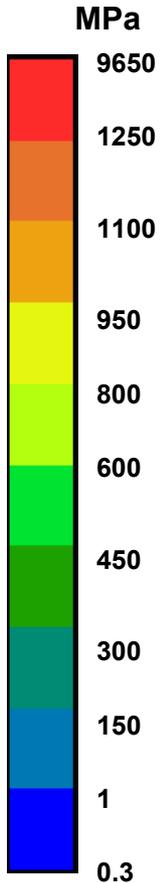
Particle is still
bearing load



*Particles
have
fractured*

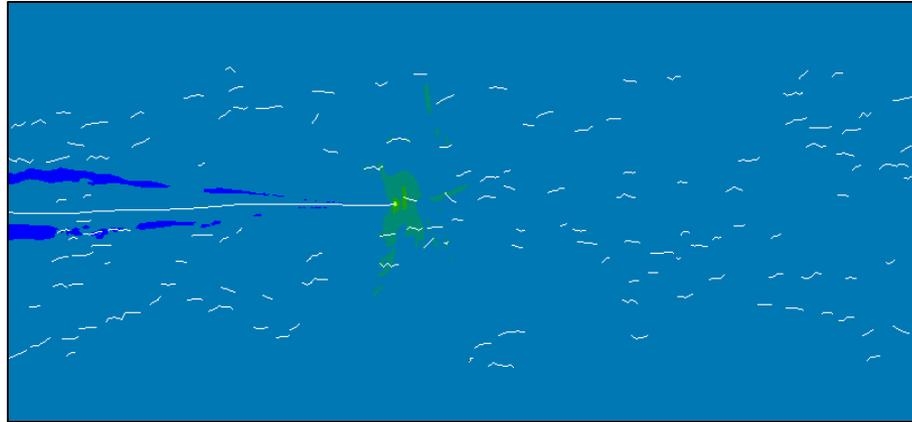


Particle has
fractured



Von Mises stress contours for varying loads

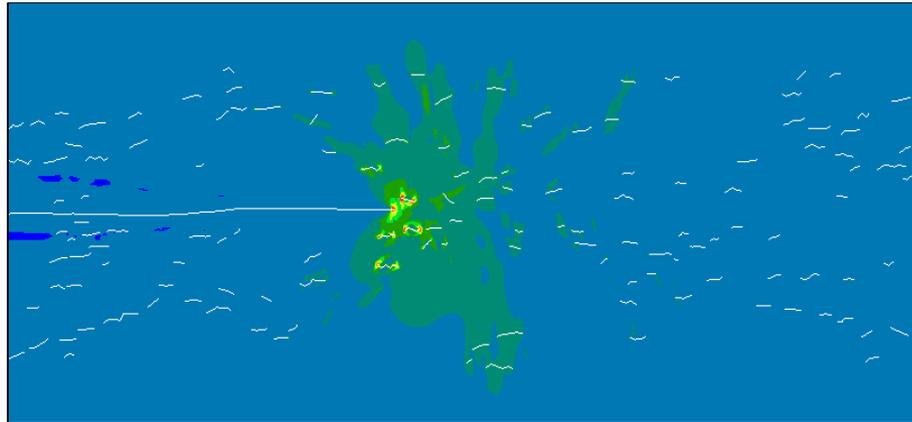
Applied stress of **7** MPa



No particle fracture

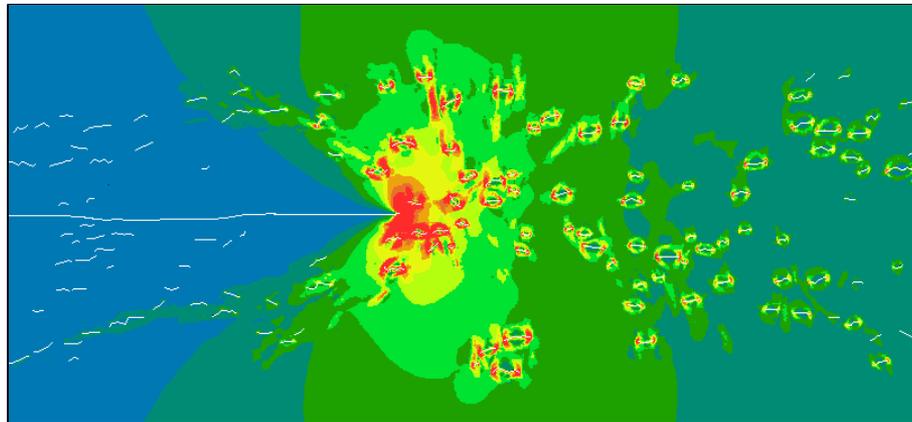
Crack growth direction
→

Applied stress of **14** MPa



Particles have fractured

Applied stress of **48** MPa



MPa

9650

1250

1100

950

800

600

450

300

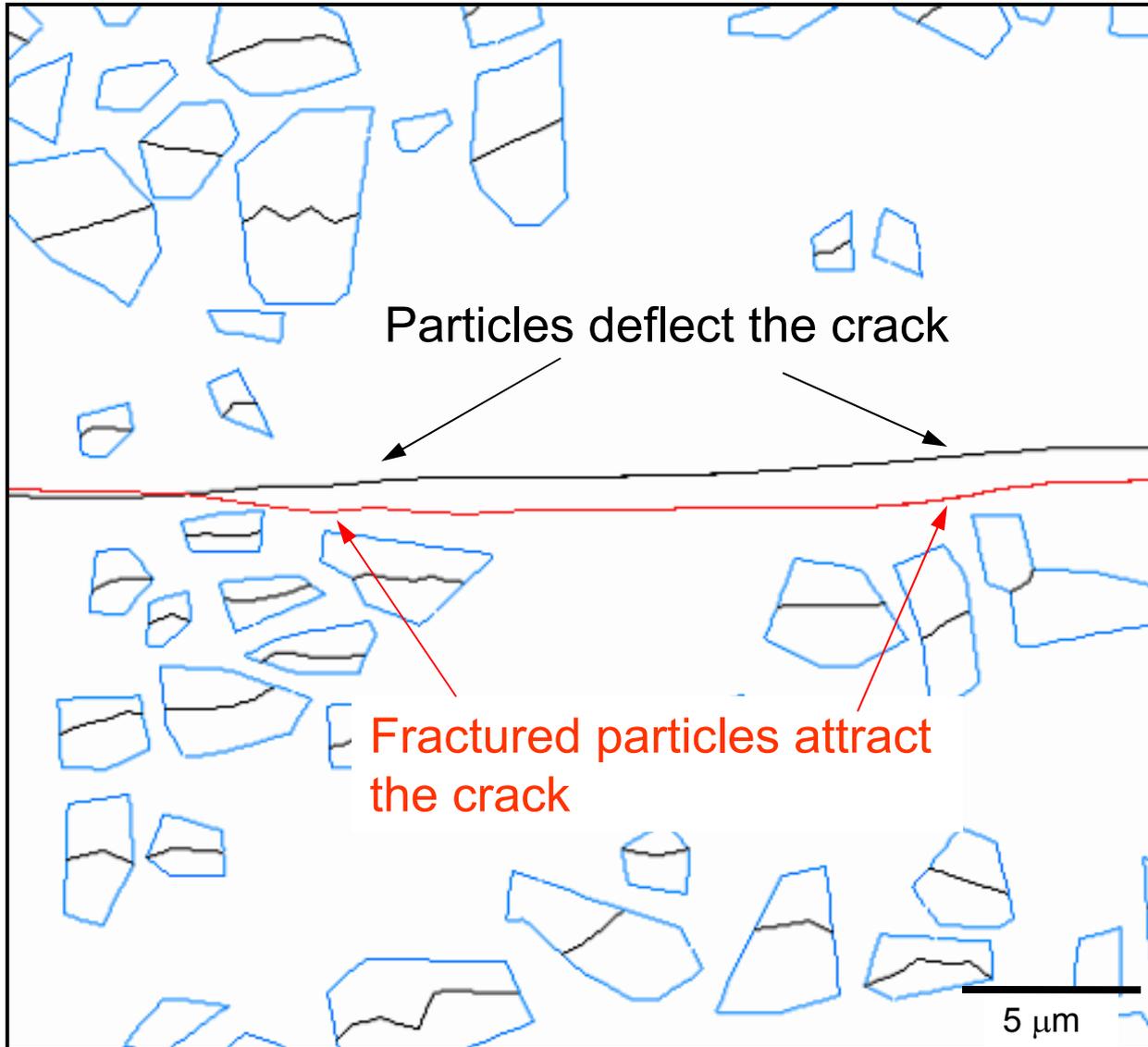
150

1

0.3

Influence of particle fracture on crack trajectory

Crack growth direction

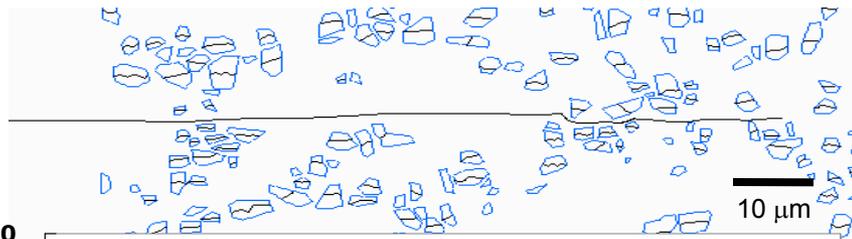


— Applied stress of 7 MPa

— Applied stress of 48 MPa

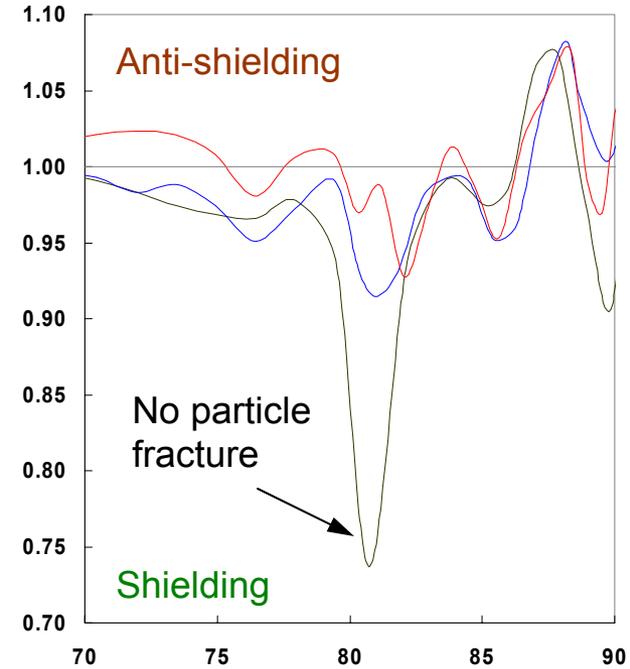
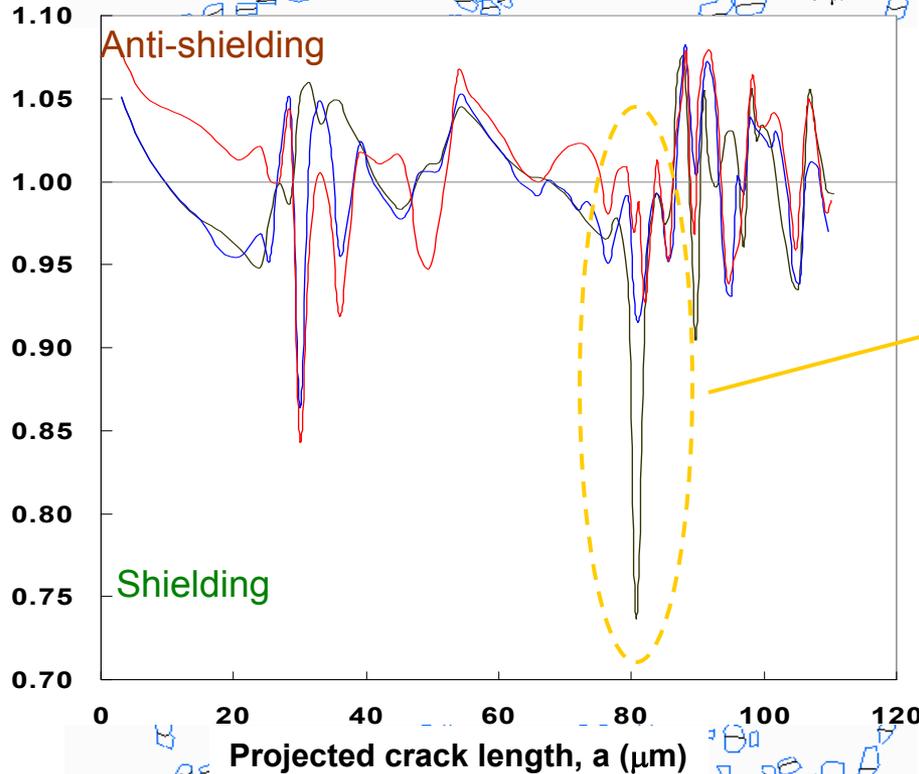
Normalized SIF vs. crack length

Applied stress of 7 MPa

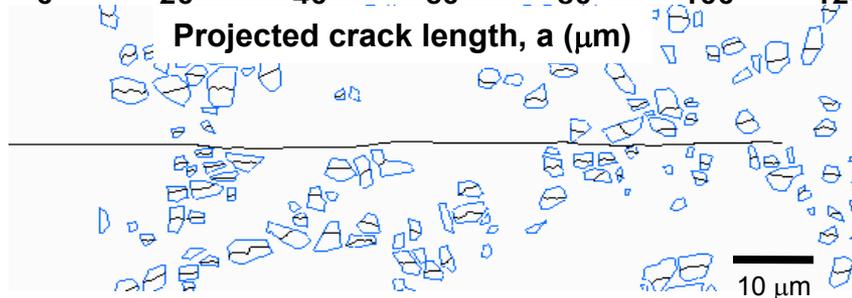


Crack growth direction →

$$\frac{k_I(AlSiC)}{k_I(cp)}$$



Applied stress of 14 MPa

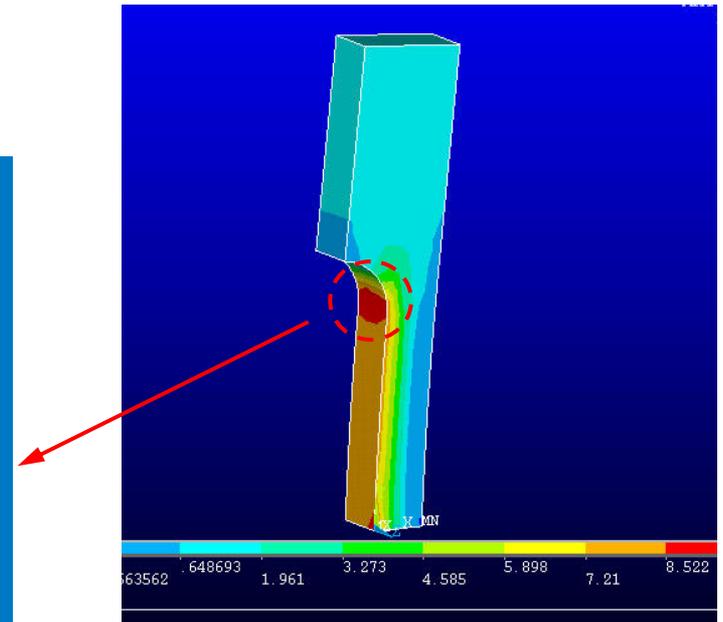
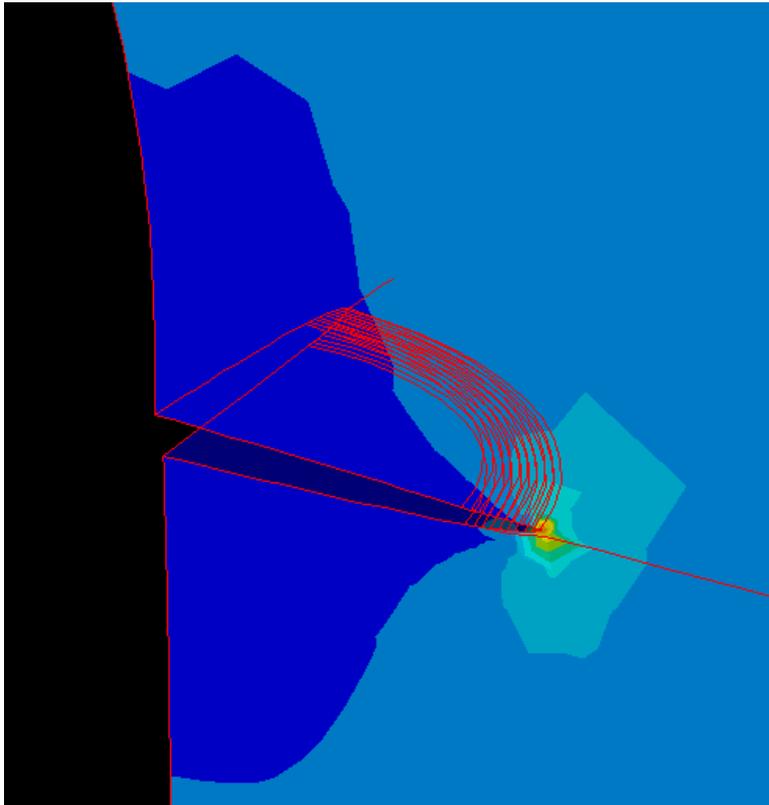


Applied stress of 48 MPa

Particle fracture influences the crack-tip driving force

Ongoing research

- Modeling particle (SiC) fracture in 3D models
- Clustering analysis in 3D
- Modeling crack growth in 3D



Acknowledgments

- Postdocs: X. Deng (Kennametal) and J.J. Williams
- Graduate Students: R. Saha, B. Wunsch (MIT), and V.V. Ganesh (Intel)
- Office of Naval Research (ONR)
 - N00014-01-1-0694 (Program Manager: A.K. Vasudevan)
- High Temperature Materials Laboratory User Program (ORNL)
- M. James and D. Swenson, "FRANC2D/L: A Crack Propagation Simulator for Plane Layered Structures," available from <http://www.mne.ksu.edu/~franc2d/>.

E-mail: nchawla@asu.edu
www.eas.asu.edu/~cme/cme-faculty/chawla